

## FEATURES

- 120 dB dynamic range at 78 kHz output data rate
- 109 dB dynamic range at 625 kHz output data rate
- 112 dB SNR at 78 kHz output data rate
- 107 dB SNR at 625 kHz output data rate
- 625 kHz maximum fully filtered output word rate
- Programmable oversampling rate (32× to 256×)
- Flexible serial interface
- Fully differential modulator input
- On-chip differential amplifier for signal buffering
- Low-pass finite impulse response (FIR) filter with default or user-programmable coefficients
- Overrange alert bit
- Digital offset and gain correction registers
- Low power and power-down modes
- Synchronization of multiple devices via SYNC pin
- I<sup>2</sup>S interface mode

## APPLICATIONS

**Data acquisition systems**  
**Vibration analysis**  
**Instrumentation**

## GENERAL DESCRIPTION

The [AD7763](#) high performance, 24-bit,  $\Sigma$ - $\Delta$  analog-to-digital converter (ADC) combines wide input bandwidth and high speed with the benefits of  $\Sigma$ - $\Delta$  conversion, as well as performance of 107 dB SNR at 625 kSPS, making it ideal for high speed data acquisition. A wide dynamic range, combined with significantly reduced antialiasing requirements, simplifies the design process. An integrated buffer to drive the reference, a differential amplifier for signal buffering and level shifting, an overrange flag, internal gain and offset registers, and a low-pass, digital FIR filter make the [AD7763](#) a compact, highly integrated data acquisition device requiring minimal peripheral component selection. In addition, the device offers programmable decimation rates and a digital FIR filter, which can be user-programmed to ensure that its characteristics are tailored for the user's application. The [AD7763](#) is ideal for applications demanding high SNR without necessitating the design of complex, front-end signal processing.

## FUNCTIONAL BLOCK DIAGRAM

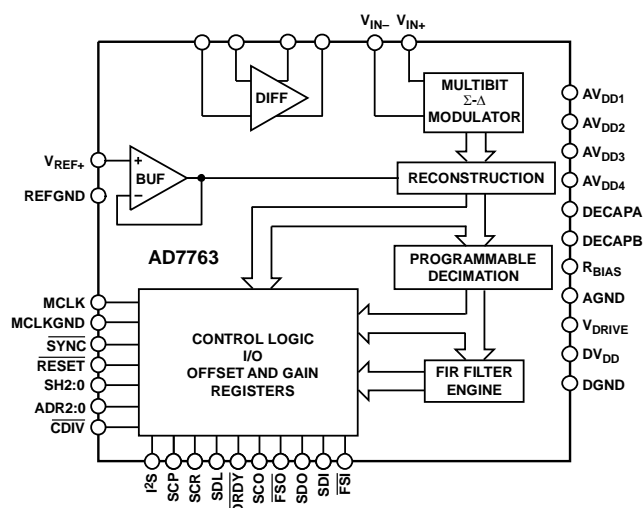


Figure 1.

The differential input is sampled at up to 40 MSPS by an analog modulator. The modulator output is processed by a series of low-pass filters, the final filter having default or user-programmable coefficients. The sample rate, filter corner frequencies, and output word rate are set by a combination of the external clock frequency and the configuration registers of the [AD7763](#).

The reference voltage supplied to the [AD7763](#) determines the analog input range. With a 4 V reference, the analog input range is  $\pm 3.2$  V differential-biased around a common mode of 2 V. This common-mode biasing can be achieved using the on-chip differential amplifiers, further reducing the external signal conditioning requirements.

The [AD7763](#) is available in an exposed paddle, 64-lead TQFP\_EP and is specified over the industrial temperature range from  $-40^{\circ}\text{C}$  to  $+85^{\circ}\text{C}$ .

### Table 1. Related Devices

| Part No. | Description   |
|----------|---|
| AD7760   | 24-bit, 2.5 MSPS, 100 dB $\Sigma$ - $\Delta$ , parallel interface |
| AD7762   | 24-bit, 625 kSPS, 109 dB $\Sigma$ - $\Delta$ , parallel interface |

**Rev. B**

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# AD7763\* PRODUCT PAGE QUICK LINKS

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## COMPARABLE PARTS

View a parametric search of comparable parts.

## EVALUATION KITS

- AD7763 Evaluation Kit

## DOCUMENTATION

### Application Notes

- AN-280: Mixed Signal Circuit Technologies
- AN-282: Fundamentals of Sampled Data Systems
- AN-283: Sigma-Delta ADCs and DACs
- AN-311: How to Reliably Protect CMOS Circuits Against Power Supply Overvoltage
- AN-342: Analog Signal-Handling for High Speed and Accuracy
- AN-388: Using Sigma-Delta Converters-Part 1
- AN-389: Using Sigma-Delta Converters-Part 2

### Data Sheet

- AD7763: 24-Bit, 625 kSPS, 109 dB Sigma-Delta ADC with On Chip Buffers, Serial Interface Data Sheet

## SOFTWARE AND SYSTEMS REQUIREMENTS

- CED1Z FPGA Project for AD7763 with Nios driver
- EVAL-AD7763EDZ - AD7763 Evaluation Board - Software

## TOOLS AND SIMULATIONS

- Sigma-Delta ADC Tutorial

## REFERENCE MATERIALS

### Technical Articles

- MS-2210: Designing Power Supplies for High Speed ADC
- Vibration Analysis Using ADCs Keeps Industrial Equipment Working

## DESIGN RESOURCES

- AD7763 Material Declaration
- PCN-PDN Information
- Quality And Reliability
- Symbols and Footprints

## DISCUSSIONS

View all AD7763 EngineerZone Discussions.

## SAMPLE AND BUY

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## DOCUMENT FEEDBACK

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## REVISION HISTORY

### 1/14—Rev. A to Rev. B

|  |    |
|--|----|
| Added Exposed Pad Notation, Figure 4 and Table 5 ..... | 8  |
| Change to Figure 37 .....                              | 24 |
| Updated Outline Dimensions .....                       | 29 |

### 11/09—Rev. 0 to Rev. A

|   |    |
|---|----|
| Changes to Figure 5.....                        | 8  |
| Changes to Sharing the Serial Bus Section ..... | 15 |
| Changes to Figure 26.....                       | 16 |
| Updated Outline Dimensions .....                | 29 |
| Changes to Ordering Guide .....                 | 29 |

### 10/05—Revision 0: Initial Version

## SPECIFICATIONS

$AV_{DD1} = DV_{DD} = V_{DRIVE} = 2.5\text{ V}$ ;  $AV_{DD2} = AV_{DD3} = AV_{DD4} = 5\text{ V}$ ;  $V_{REF} = 4.096\text{ V}$ ; MCLK amplitude = 5 V;  $T_A = 25^\circ\text{C}$ ; normal mode, using on-chip amplifier with components as shown in Table 10, unless otherwise noted.<sup>1</sup>

Table 2.

| Parameter                                | Test Conditions/Comments  | Specification | Unit        |
|--|---|---------------|-------------|
| DYNAMIC PERFORMANCE                      |   |               |             |
| Decimate × 256                           | MCLK = 40 MHz, ODR = 78 kHz, F <sub>IN</sub> = 1 kHz                  |               |             |
| Dynamic Range                            | Modulator inputs shorted  | 119           | dB min      |
|  |   | 120.5         | dB typ      |
| Signal-to-Noise Ratio (SNR) <sup>2</sup> | Input amplitude = −0.5 dBFS   | 112           | dB typ      |
|  | Input amplitude = −60 dB  | 59            | dBc typ     |
| Spurious-Free Dynamic Range (SFDR)       | Nonharmonic, input amplitude = −6 dB                                  | 126           | dBc typ     |
|  | Input amplitude = −60 dB  | 77            | dBc typ     |
| Total Harmonic Distortion (THD)          | Input amplitude = −0.5 dBFS   | −105          | dB typ      |
|  | Input amplitude = −6 dB   | −106          | dBc typ     |
|  | Input amplitude = −60 dB  | −75           | dBc typ     |
| Decimate × 64                            | MCLK = 40 MHz, ODR = 312.5 kHz, F <sub>IN</sub> = 1 kHz               |               |             |
| Dynamic Range                            | Modulator inputs shorted  | 112           | dB min      |
|  |   | 113           | dB typ      |
| Signal-to-Noise Ratio (SNR) <sup>2</sup> | Input amplitude = −0.5 dBFS   | 109.5         | dB typ      |
| Spurious-Free Dynamic Range (SFDR)       | Nonharmonic, input amplitude = −6 dB                                  | 126           | dBc typ     |
| Decimate × 32                            | MCLK = 40 MHz, ODR = 625 kHz, F <sub>IN</sub> = 100 kHz               |               |             |
| Dynamic Range                            | Modulator inputs shorted  | 108           | dB min      |
|  |   | 109.5         | dB typ      |
| Signal-to-Noise Ratio (SNR) <sup>2</sup> | Input amplitude = −0.5 dBFS   | 107           | dB typ      |
| Spurious-Free Dynamic Range (SFDR)       | Nonharmonic, input amplitude = −6 dB                                  | 120           | dBc typ     |
| Total Harmonic Distortion (THD)          | Input amplitude = −0.5 dBFS   | −105          | dB typ      |
|  | Input amplitude = −6 dB   | −107          | dBc typ     |
| DC ACCURACY                              |   |               |             |
| Resolution                               | Guaranteed monotonic to 24 bits                                       | 24            | Bits        |
| Differential Nonlinearity                |   |               |             |
| Integral Nonlinearity                    |   | 0.00076       | % typ       |
| Zero Error                               |   | 0.014         | % typ       |
|  |   | 0.02          | % max       |
| Gain Error                               |   | 0.018         | % typ       |
| Zero Error Drift                         |   | 10            | μ%FS/°C typ |
| Gain Error Drift                         | 0.0002  | %FS/°C typ    |             |
| DIGITAL FILTER RESPONSE                  |   |               |             |
| Decimate × 32                            | MCLK = 40 MHz   | 47            | μs typ      |
| Group Delay                              |   |               |             |
| Decimate × 64                            | MCLK = 40 MHz   | 91.5          | μs typ      |
| Group Delay                              |   |               |             |
| Decimate × 256                           | MCLK = 40 MHz   | 358           | μs typ      |
| Group Delay                              |   |               |             |
| ANALOG INPUT                             |   |               |             |
| Differential Input Voltage               | V <sub>IN</sub> (+) − V <sub>IN</sub> (−), V <sub>REF</sub> = 2.5 V   | ±2            | V p-p       |
|  | V <sub>IN</sub> (+) − V <sub>in</sub> (−), V <sub>REF</sub> = 4.096 V | ±3.25         | V p-p       |
| Input Capacitance                        | At internal buffer inputs   | 5             | pF typ      |
|  | At modulator inputs   | 55            | pF typ      |

| Parameter                                  | Test Conditions/Comments              | Specification          | Unit                   |
|--|---------------------------------------|------------------------|------------------------|
| REFERENCE INPUT                            |                                       |                        |                        |
| $V_{REF}$ Input Voltage                    | $V_{DD3} = 3.3 \text{ V} \pm 5\%$     | +2.5                   | V max                  |
| $V_{REF}$ Input DC Leakage Current         | $V_{DD3} = 5 \text{ V} \pm 5\%$       | +4.096                 | V max                  |
| $V_{REF}$ Input Capacitance                |                                       | $\pm 1$                | $\mu\text{A}$ max      |
|  |                                       | 5                      | pF max                 |
| POWER DISSIPATION                          |                                       |                        |                        |
| Total Power Dissipation                    | Normal power mode                     | 955.5                  | mW max                 |
|  | Low power mode                        | 651                    | mW max                 |
| Standby Mode                               | Clock stopped                         | 6.35                   | mW typ                 |
| POWER REQUIREMENTS                         |                                       |                        |                        |
| $AV_{DD1}$ (Modulator Supply)              | $\pm 5\%$                             | +2.5                   | V                      |
| $AV_{DD2}$ (General Supply)                | $\pm 5\%$                             | +5                     | V                      |
| $AV_{DD3}$ (Differential Amplifier Supply) |                                       | +3.15/+5.25            | V min/max              |
| $AV_{DD4}$ (Reference Buffer Supply)       |                                       | +3.15/+5.25            | V min/max              |
| $DV_{DD}$                                  | $\pm 5\%$                             | +2.5                   | V                      |
| $V_{DRIVE}$                                |                                       | +1.65/+2.7             | V min/max              |
| Normal Mode                                |                                       |                        |                        |
| $AI_{DD1}$ (Modulator)                     |                                       | 49/52                  | mA typ/max             |
| $AI_{DD2}$ (General)                       |                                       | 40/43                  | mA typ/max             |
| $AI_{DD4}$ (Reference Buffer)              | $AV_{DD4} = 5 \text{ V}$              | 35/37                  | mA typ/max             |
| Low Power Mode                             |                                       |                        |                        |
| $AI_{DD1}$ (Modulator)                     |                                       | 26/28                  | mA typ/max             |
| $AI_{DD2}$ (General)                       |                                       | 20/23                  | mA typ/max             |
| $AI_{DD4}$ (Reference Buffer)              | $AV_{DD4} = 5 \text{ V}$              | 10/11                  | mA typ/max             |
| $AI_{DD3}$ (Diff Amp)                      | $AV_{DD3} = 5 \text{ V}$ , both modes | 41/45                  | mA typ/max             |
| $DI_{DD}$                                  | Both modes                            | 56/62                  | mA typ/max             |
| DIGITAL I/O                                |                                       |                        |                        |
| MCLK Input Amplitude <sup>3</sup>          |                                       | 5                      | V typ                  |
| Input Capacitance                          |                                       | 7.3                    | pF typ                 |
| Input Leakage Current                      |                                       | $\pm 1$                | $\mu\text{A}$ /pin max |
| Three-State Leakage Current (SDO)          |                                       | $\pm 1$                | $\mu\text{A}$ max      |
| $V_{INH}$                                  |                                       | $0.7 \times V_{DRIVE}$ | V min                  |
| $V_{INL}$                                  |                                       | $0.3 \times V_{DRIVE}$ | V max                  |
| $V_{OH}$ <sup>4</sup>                      |                                       | 1.5                    | V min                  |
| $V_{OL}$                                   |                                       | 0.1                    | V max                  |

<sup>1</sup> See the Terminology section.

<sup>2</sup> SNR specifications in dB are referred to a full-scale input, FS, and tested with an input signal at 0.5 dB below full scale, unless otherwise specified.

<sup>3</sup> While the AD7763 can function with an MCLK amplitude of less than 5 V, this is the recommended amplitude to achieve the performance as stated.

<sup>4</sup> Tested with a 400  $\mu\text{A}$  load current.

## TIMING SPECIFICATIONS

$AV_{DD1} = DV_{DD} = V_{DRIVE} = 2.5\text{ V}$ ,  $AV_{DD2} = AV_{DD3} = AV_{DD4} = 5\text{ V}$ ,  $T_A = 25^\circ\text{C}$ , normal mode, unless otherwise noted.

Table 3.

| Parameter      | Limit at $T_{MIN}$ , $T_{MAX}$                 | Unit               | Description                                       |
|----------------|--|--------------------|---|
| $f_{MCLK}$     | 1<br>40  | MHz min<br>MHz max | Applied master clock frequency                    |
| $f_{ICLK}$     | 500<br>20                                      | kHz min<br>MHz max | Internal modulator clock derived from MCLK        |
| $t_1^1$        | $1 \times t_{ICLK}$ or $0.5 \times t_{ICLK}^2$ | typ                | SCO high period                                   |
| $t_2^1$        | $1 \times t_{ICLK}$ or $0.5 \times t_{ICLK}^2$ | typ                | SCO low period                                    |
| $t_3$          | $t_{SCO}^3$                                    | typ                | $\overline{DRDY}$ low period                      |
| $t_{3A}^4$     | 2  | ns typ             | SCO rising edge to $\overline{DRDY}$ falling edge |
| $t_{3B}^4$     | 3  | ns typ             | SCO rising edge to $\overline{DRDY}$ rising edge  |
| $t_4^5$        | $32 \times t_{SCO}^3$                          | typ                | $\overline{FSO}$ low period                       |
| $t_{4A}^{4,5}$ | 1  | ns typ             | SCO rising edge to $\overline{FSO}$ falling edge  |
| $t_{4B}^{4,5}$ | 2  | ns typ             | SCO falling edge to $\overline{FSO}$ rising edge  |
| $t_5$          | 6.5  | ns max             | Initial data access time                          |
| $t_6^4$        | 5  | ns max             | SCO rising edge to SDO valid                      |
| $t_7$          | $0.5 \times t_{SCO}^3$                         | ns min             | SDO valid after SCO falling edge                  |
| $t_8$          | $16 \times t_{SCO}^3$                          | typ                | $\overline{DRDY}$ rising edge to SDL falling edge |
| $t_9$          | $t_{SCO}^3$                                    | typ                | SDL pulse width                                   |
| $t_{10}$       | 5.5  | ns max             | SDO three-state to SCO rising edge                |
| $t_{11}$       | $1 \times t_{SCO}^3$                           | min                | $\overline{FSI}$ low period                       |
| $t_{12}$       | 12   | ns min             | SDI setup time                                    |
| $t_{13}$       | 10   | ns min             | SDI hold time                                     |
| $t_{14}$       | 12   | ns min             | $\overline{FSI}$ setup time                       |
| $t_{15}$       | $16 \times t_{SCO}^3$                          | typ                | SDL falling edge to SDL falling edge              |

<sup>1</sup>  $t_{ICLK} = 1/f_{ICLK}$ .

<sup>2</sup> SCO frequency selected by SCR and  $\overline{CDIV}$  pins.

<sup>3</sup>  $t_{SCO} = t_1 + t_2$ .

<sup>4</sup> All edges mentioned refer to SCP = 0. Invert SCO edges for SCP = 1.

<sup>5</sup> In decimate  $\times 32$  mode, this time specification applies only when  $\overline{CDIV} = 0$  and SCR = 1. For all other combinations of  $\overline{CDIV}$  and SCR in decimate  $\times 32$  mode, the FSO signal is constantly logic low.

## TIMING DIAGRAMS

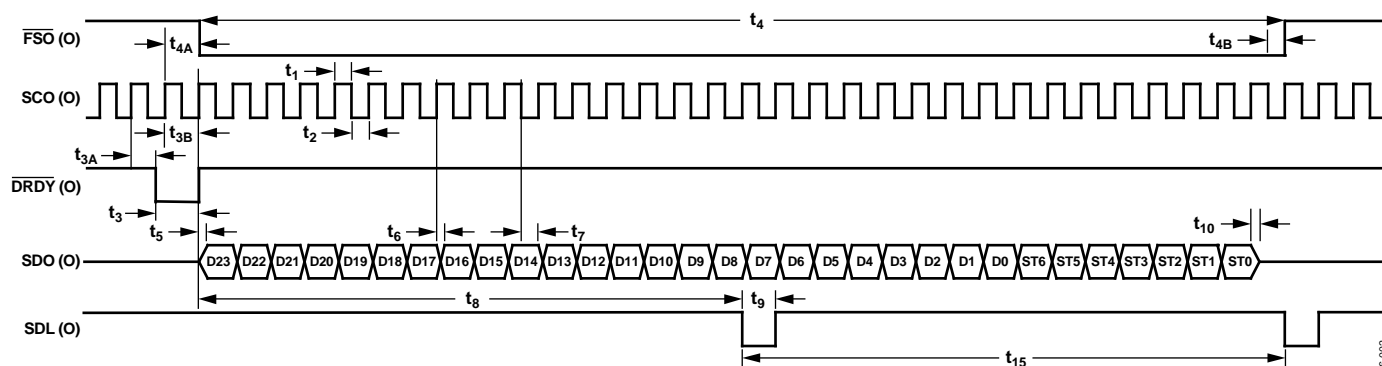


Figure 2. SPI® Interface Serial Read Timing Diagram

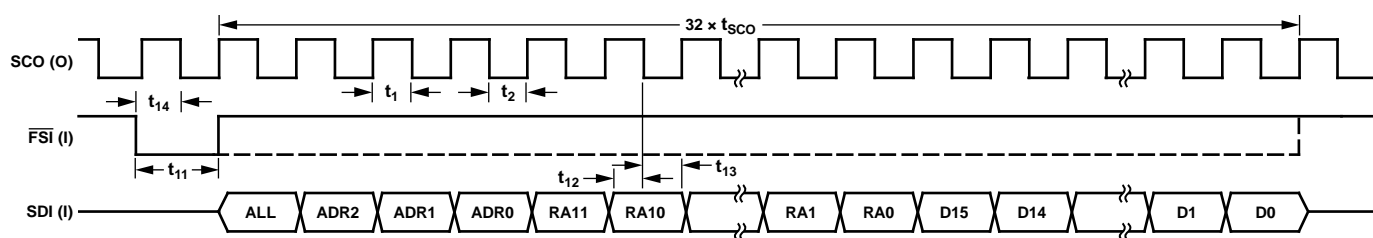


Figure 3. Register Write

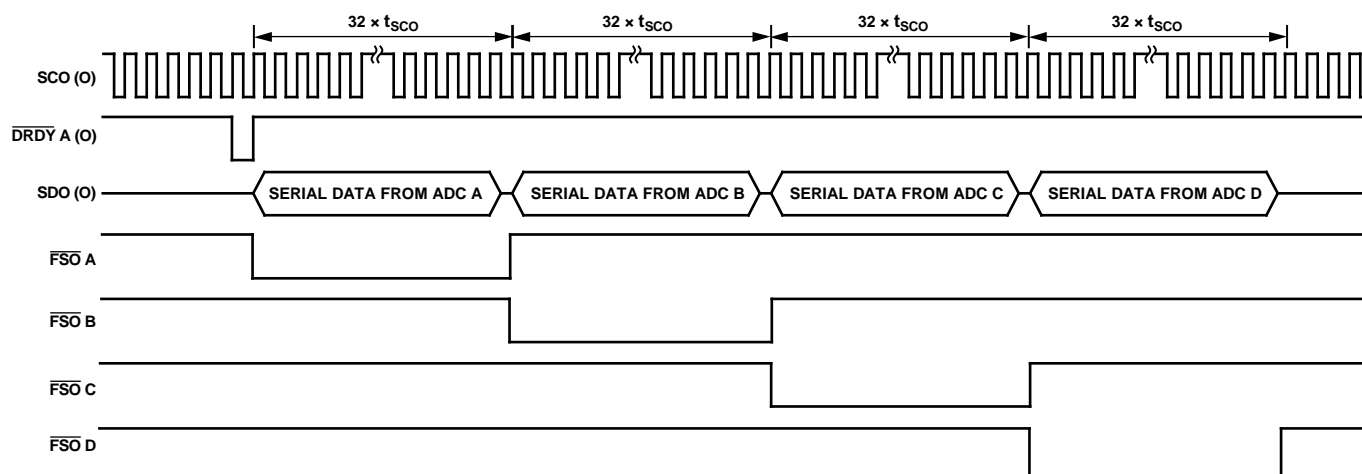


Figure 4. SPI Interface Serial Read Timing with Multiple AD7763 Devices Sharing the Serial Bus

## ABSOLUTE MAXIMUM RATINGS

$T_A = 25^\circ\text{C}$ , unless otherwise noted.

**Table 4.**

| Parameter  | Rating                       |
|--|------------------------------|
| $AV_{DD1}$ to GND  | −0.3 V to +3 V               |
| ( $AV_{DD2}$ , $AV_{DD3}$ , $AV_{DD4}$ ) to GND          | −0.3 V to +6 V               |
| $DV_{DD}$ to GND   | −0.3 V to +3 V               |
| $V_{DRIVE}$ to GND                                       | −0.3 V to +3 V               |
| $V_{IN+}$ , $V_{IN-}$ to GND                             | −0.3 V to +6 V               |
| Digital Input Voltage to GND <sup>1</sup>                | −0.3 V to $DV_{DD} + 0.3$ V  |
| MCLK to MCLKGND  | −0.3 V to +6 V               |
| $V_{REF}$ to GND <sup>2</sup>                            | −0.3 V to $AV_{DD4} + 0.3$ V |
| AGND to DGND   | −0.3 V to +0.3 V             |
| Input Current to Any Pin<br>Except Supplies <sup>3</sup> | ±10 mA                       |
| Operating Temperature Range<br>Commercial                | −40°C to +85°C               |
| Storage Temperature Range                                | −65°C to +150°C              |
| Junction Temperature                                     | 150°C                        |
| TQFP_EP Exposed Paddle                                   |                              |
| $\theta_{JA}$ Thermal Impedance                          | 92.7°C/W                     |
| $\theta_{JC}$ Thermal Impedance                          | 5.1°C/W                      |
| Lead Temperature, Soldering                              |                              |
| Vapor Phase (60 sec)                                     | 215°C                        |
| Infrared (15 sec)  | 220°C                        |
| ESD  | 600 V                        |

<sup>1</sup> Absolute maximum voltage on digital inputs is 3.0 V or  $DV_{DD} + 0.3$  V, whichever is lower.

<sup>2</sup> Absolute maximum voltage on  $V_{REF}$  input is 6.0 V or  $AV_{DD4} + 0.3$  V, whichever is lower.

<sup>3</sup> Transient currents of up to 200 mA do not cause SCR latch-up.

Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only; functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

### ESD CAUTION

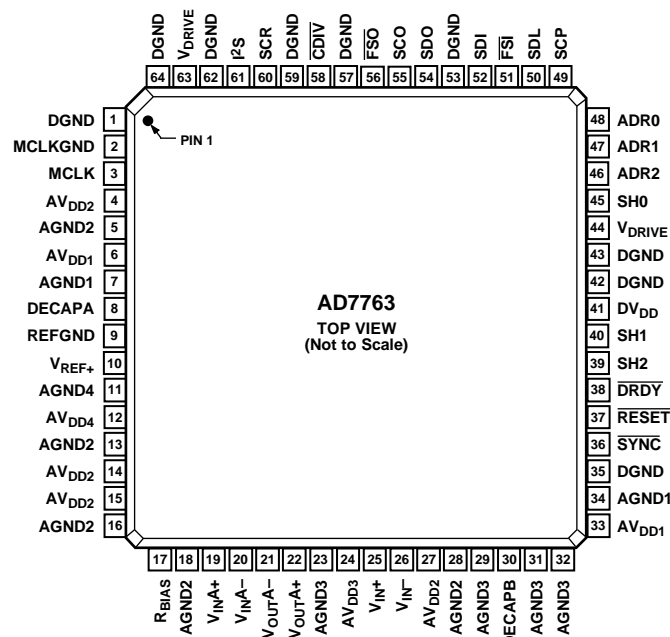


#### ESD (electrostatic discharge) sensitive device.

Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.



## PIN CONFIGURATION AND FUNCTION DESCRIPTIONS



## NOTES

1. CONNECT THE EXPOSED PAD TO AGNDx WITH SIX TO EIGHT VIAS.

05476-005

Figure 5. Pin Configuration

Table 5. Pin Function Descriptions

| Pin No.                           | Mnemonic           | Description   |
|-----------------------------------|--------------------|---|
| 6, 33                             | AV <sub>DD1</sub>  | Power Supply for Modulator, 2.5 V. These pins should be decoupled to AGND1 with 100 nF and 10 $\mu$ F capacitors on each pin.   |
| 4, 14, 15, 27                     | AV <sub>DD2</sub>  | Power Supply, 5 V. These pins should be decoupled to AGND2 with 100 nF capacitors on each of Pin 4, Pin 14, and Pin 15. Pin 27 should be connected to Pin 14 via an 8.2 nH inductor.  |
| 24                                | AV <sub>DD3</sub>  | Power Supply for Differential Amplifier, 3.3 V to 5 V. This pin should be decoupled to AGND3 with a 100 nF capacitor.   |
| 12                                | AV <sub>DD4</sub>  | Power Supply for Reference Buffer, 3.3 V to 5 V. This pin should be decoupled to AGND4 with a 10 nF capacitor in series with a 10 $\Omega$ resistor.  |
| 7, 34                             | AGND1              | Power Supply Ground for Analog Circuitry Powered by AV <sub>DD1</sub> .   |
| 5, 13, 16, 18, 28                 | AGND2              | Power Supply Ground for Analog Circuitry Powered by AV <sub>DD2</sub> .   |
| 23, 29, 31, 32                    | AGND3              | Power Supply Ground for Analog Circuitry Powered by AV <sub>DD3</sub> .   |
| 11                                | AGND4              | Power Supply Ground for Analog Circuitry Powered by AV <sub>DD4</sub> .   |
| 9                                 | REFGND             | Reference Ground. Ground connection for the reference voltage.  |
| 41                                | DV <sub>DD</sub>   | Power Supply for Digital Circuitry and FIR Filter, 2.5 V. This pin should be decoupled to DGND with a 100 nF capacitor.   |
| 44, 63                            | V <sub>DRIVE</sub> | Logic Power Supply Input, 1.8 V to 2.5 V. The voltage supplied at these pins determines the operating voltage of the logic interface. These pins must be connected together and tied to the same supply. Each pin should also be decoupled to DGND with a 100 nF capacitor. |
| 1, 35, 42, 43, 53, 57, 59, 62, 64 | DGND               | Ground Reference for Digital Circuitry.   |
| 19                                | V <sub>INA+</sub>  | Positive Input to Differential Amplifier.   |
| 20                                | V <sub>INA-</sub>  | Negative Input to Differential Amplifier.   |
| 21                                | V <sub>OUTA-</sub> | Negative Output from Differential Amplifier.  |
| 22                                | V <sub>OUTA+</sub> | Positive Output from Differential Amplifier.  |
| 25                                | V <sub>IN+</sub>   | Positive Input to the Modulator.  |
| 26                                | V <sub>IN-</sub>   | Negative Input to the Modulator.  |
| 10                                | V <sub>REF+</sub>  | Reference Input. The input range of this pin is determined by the reference buffer supply voltage (AV <sub>DD4</sub> ). See the Reference Voltage Filtering section for more details.   |

| Pin No.    | Mnemonic                  | Description   |
|------------|---------------------------|---|
| 8          | DECAPA                    | Decoupling Pin. A 100 nF capacitor must be inserted between this pin and AGND1.   |
| 30         | DECAPB                    | Decoupling Pin. A 33 pF capacitor must be inserted between this pin and AGND3.  |
| 17         | R <sub>BIAS</sub>         | Bias Current Setting. A resistor must be inserted between this pin and AGND. See the Bias Resistor Selection section.   |
| 37         | $\overline{\text{RESET}}$ | A falling edge on this pin resets all internal digital circuitry. Holding this pin low keeps the AD7763 in a reset state.   |
| 3          | MCLK                      | Master Clock Input. A low jitter digital clock must be applied to this pin. The output data rate depends on the frequency of this clock. See the Clocking the AD7763 section.   |
| 2          | MCLKGND                   | Master Clock Ground Sensing Pin.  |
| 36         | $\overline{\text{SYNC}}$  | Synchronization Input. A falling edge on this pin resets the internal filter. This can be used to synchronize multiple devices in a system.   |
| 38         | $\overline{\text{DRDY}}$  | Data Ready Output. Each time new conversion data is available, an active low pulse, ½ ICLK period wide, is produced on this pin. See the AD7763 Interface section.  |
| 39, 40, 45 | SH2:0                     | Share Pins 2:0. For multiple AD7763 devices sharing a common serial bus. Each device is wired with the binary value that represents the number of devices sharing the serial bus. SH2 is the MSB. See the Sharing the Serial Bus section.   |
| 46 to 48   | ADR2:0                    | Address 2:0. Allows multiple AD7763 devices to share a common serial bus. Each device must be programmed with an individual address using these three pins. See the Sharing the Serial Bus section.   |
| 49         | SCP                       | Serial Clock Polarity. Determines on which edge of SCO the data bits are clocked out and on which edge they are valid. All timing diagrams are shown with SCP = 0, and all SCO edges shown should be inverted for SCP = 1.  |
| 50         | SDL                       | Serial Data Latch. A pulse is output on this pin after every 16 data bits. The pulse is one SCO period wide and can be used in conjunction with $\overline{\text{FSO}}$ as an alternative framing method for serial transfers requiring a framing signal more frequent than every 32 bits.  |
| 51         | $\overline{\text{FSI}}$   | Frame Sync In. The status of this pin is checked on the falling edge of SCO. If this pin is low, then the first data bit is latched in on the next SCO falling edge when SCP = 0 or on the rising edge of SCO if SCP = 1.   |
| 52         | SDI                       | Serial Data In. The first data bit (MSB) must be valid on the next SCO falling edge when SCP = 0 (or SCO rising edge SCP = 1) after the $\overline{\text{FSI}}$ event has been latched. Each write requires 32 bits: the ALL bit, 3 address bits, and 12 register address bits, followed by the remaining 16 bits of data to be written to the device.  |
| 54         | SDO                       | Serial Data Out. Address, status, and data bits are clocked out on this line during each serial transfer.<br>If SCP = 0, each bit is clocked out on an SCO rising edge and is valid on the falling edge. When the I <sup>2</sup> S pin is set to logic high, this pin outputs the signal defined as SD in the I <sup>2</sup> S bus specification. See the Reading Data Using the I <sup>2</sup> S Interface section for details.  |
| 55         | SCO                       | Serial Clock Out. This clock signal is derived from the internal ICLK signal. The frequency of SCO is equal to either ICLK or ICLK/2, depending on the state of the $\overline{\text{CDIV}}$ and SCR pins (see the AD7763 Interface section). When the I <sup>2</sup> S pin is logic high, this pin outputs the signal defined as SCK by the I <sup>2</sup> S bus specification. See the Reading Data Using the I <sup>2</sup> S Interface section.   |
| 56         | $\overline{\text{FSO}}$   | Frame Sync Out. This signal frames the serial data output and is 32 SCO periods wide. The exception to the framing behavior of $\overline{\text{FSO}}$ occurs in decimate × 32 mode, where, for certain combinations of $\overline{\text{CDIV}}$ and SCR, the $\overline{\text{FSO}}$ signal is constantly logic low. See the Reading Data Using the SPI Interface section. When the I <sup>2</sup> S pin is set to logic high, this pin outputs the signal defined as WS in the I <sup>2</sup> S bus specification. See the Reading Data Using the I <sup>2</sup> S Interface section. |
| 58         | $\overline{\text{CDIV}}$  | Clock Divider. This pin is used to select the ratio of MCLK to ICLK. See the AD7763 Interface section.  |
| 60         | SCR                       | Serial Clock Rate. This pin and the $\overline{\text{CDIV}}$ pin program the SCO frequency (see Table 7).   |
| 61         | I <sup>2</sup> S          | I <sup>2</sup> S Select. A Logic 1 on this pin changes the serial data-out mode from SPI to I <sup>2</sup> S. The SDO pin outputs as the SD signal, the SCO pin outputs the SCK signal, and the $\overline{\text{FSO}}$ pin outputs the WS signal. When writing to the AD7763, the I <sup>2</sup> S pin is set to logic low and the SPI interface is used. See the Reading Data Using the I <sup>2</sup> S Interface section for further details.   |
|            | EPAD                      | Exposed Pad. Connect the exposed pad to AGNDx with six to eight vias.   |

## TERMINOLOGY

### Signal-to-Noise Ratio (SNR)

The ratio of the rms value of the actual input signal to the rms sum of all other spectral components below the Nyquist frequency, excluding harmonics and dc. The value for SNR is expressed in decibels.

### Total Harmonic Distortion (THD)

The ratio of the rms sum of harmonics to the fundamental. For the [AD7763](#), it is defined as

$$THD(\text{dB}) = 20 \log \frac{\sqrt{V_2^2 + V_3^2 + V_4^2 + V_5^2 + V_6^2}}{V_1}$$

where:

$V_1$  is the rms amplitude of the fundamental.

$V_2$ ,  $V_3$ ,  $V_4$ ,  $V_5$ , and  $V_6$  are the rms amplitudes of the second to the sixth harmonic.

### Nonharmonic Spurious-Free Dynamic Range (SFDR)

The ratio of the rms signal amplitude to the rms value of the peak spurious spectral component, excluding harmonics.

### Dynamic Range

The ratio of the rms value of the full scale to the rms noise measured with the inputs shorted together. The value for dynamic range is expressed in decibels.

### Integral Nonlinearity (INL)

The maximum deviation from a straight line passing through the endpoints of the ADC transfer function.

### Differential Nonlinearity (DNL)

The difference between the measured and the ideal 1 LSB change between any two adjacent codes in the ADC.

### Zero Error

The difference between the ideal midscale input voltage (0 V) and the actual voltage producing the midscale output code.

### Zero Error Drift

The change in the actual zero error value due to a temperature change of 1°C. It is expressed as a percentage of full scale at room temperature.

### Gain Error

The first transition (from 100...000 to 100...001) should occur for an analog voltage 1/2 LSB above the nominal negative full scale. The last transition (from 011...110 to 011...111) should occur for an analog voltage 1 1/2 LSB below the nominal full scale. The gain error is the deviation of the difference between the actual level of the last transition and the actual level of the first transition, from the difference between the ideal levels.

### Gain Error Drift

The change in the actual gain error value due to a temperature change of 1°C. It is expressed as a percentage of full scale at room temperature.

## TYPICAL PERFORMANCE CHARACTERISTICS

$AV_{DD1} = DV_{DD} = V_{DRIVE} = 2.5\text{ V}$ ,  $AV_{DD2} = AV_{DD3} = AV_{DD4} = 5\text{ V}$ ,  $V_{REF} = 4.096\text{ V}$ ,  $T_A = 25^\circ\text{C}$ , normal mode, unless otherwise noted. All FFTs are generated from 65,536 samples using a 7-term Blackman-Harris window.

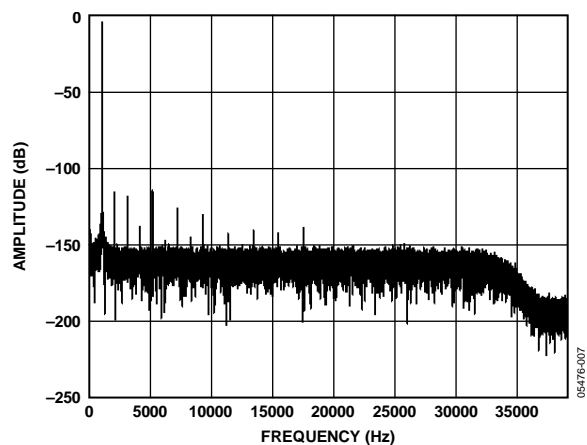


Figure 6. Normal Mode FFT, 1 kHz,  $-0.5\text{ dB}$  Input Tone, 256 $\times$  Decimation

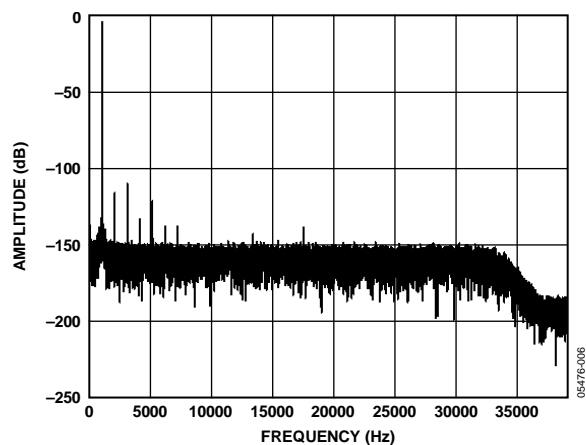


Figure 9. Low Power FFT, 1 kHz,  $-0.5\text{ dB}$  Input Tone, 256 $\times$  Decimation

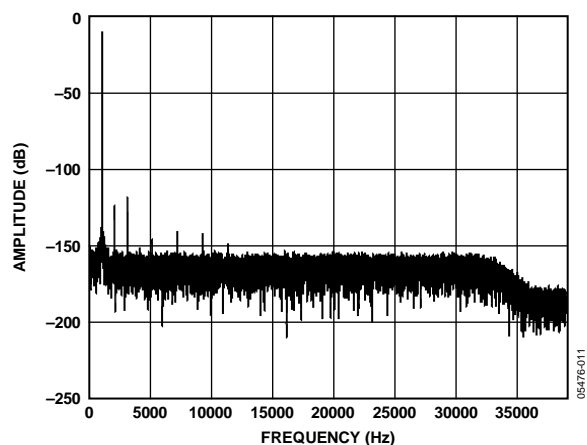


Figure 7. Normal Mode FFT, 1 kHz,  $-0.6\text{ dB}$  Input Tone, 256 $\times$  Decimation

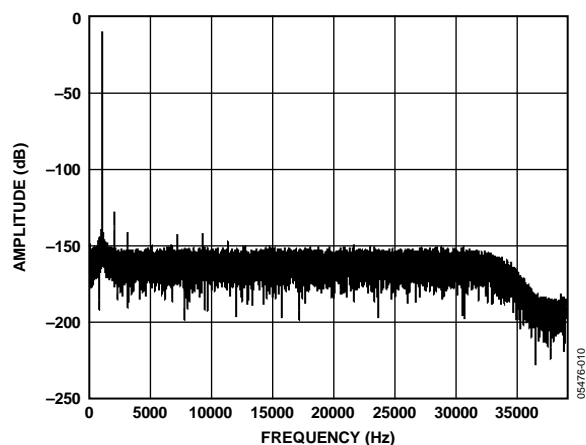


Figure 10. Low Power FFT, 1 kHz,  $-0.6\text{ dB}$  Input Tone, 256 $\times$  Decimation

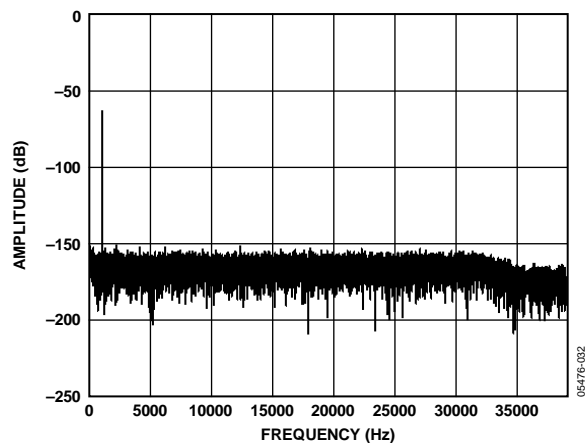


Figure 8. Normal Mode FFT, 1 kHz,  $-60\text{ dB}$  Input Tone, 256 $\times$  Decimation

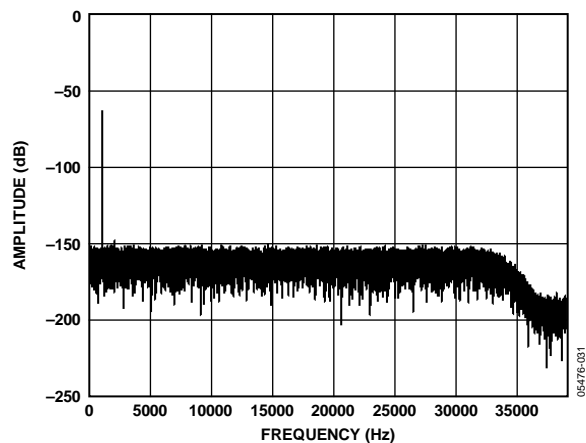


Figure 11. Low Power FFT, 1 kHz,  $-60\text{ dB}$  Input Tone, 256 $\times$  Decimation

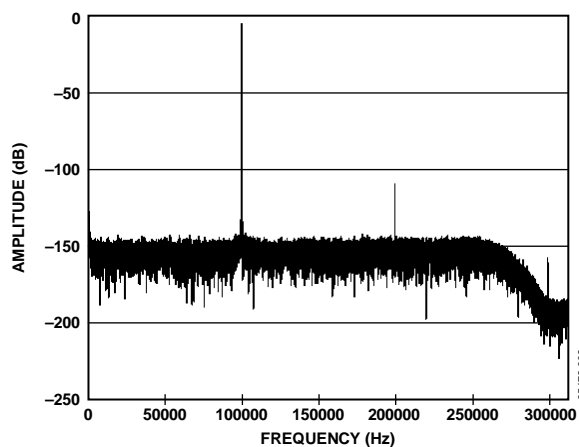


Figure 12. Normal Mode FFT, 100 kHz, -0.5 dB Input Tone, 32x Decimation

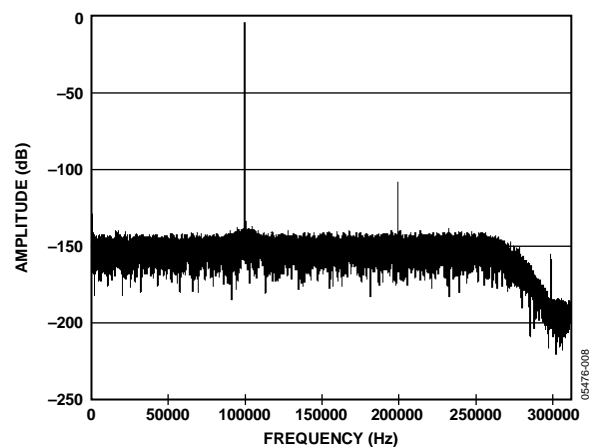


Figure 15. Low Power FFT, 100 kHz, -0.5 dB Input Tone, 32x Decimation

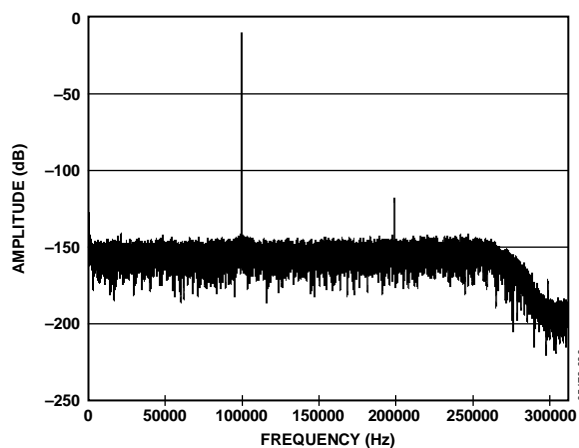


Figure 13. Normal Mode FFT, 100 kHz, -6 dB Input Tone, 32x Decimation

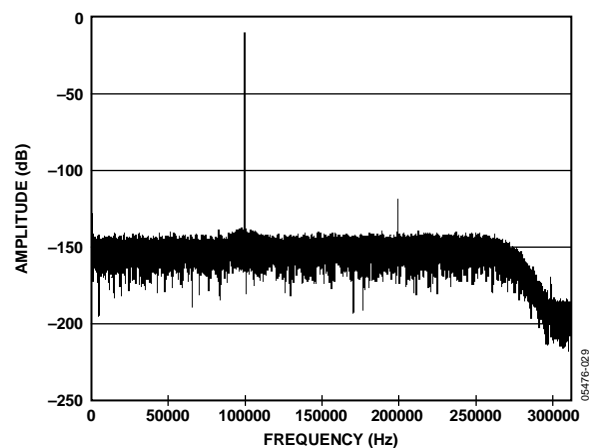


Figure 16. Low Power FFT, 100 kHz, -6 dB Input Tone, 32x Decimation

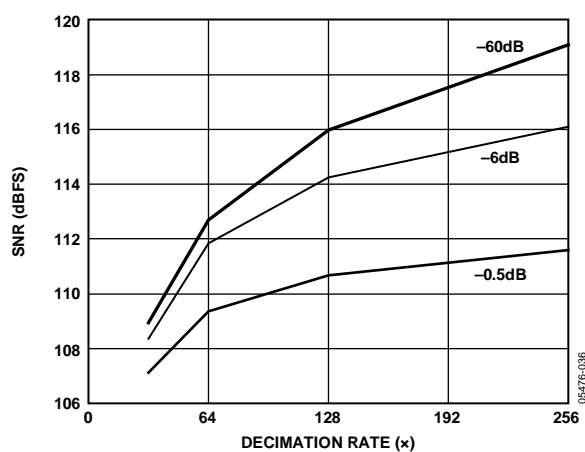


Figure 14. Normal Mode SNR vs. Decimation Rate, 1 kHz Input Tone

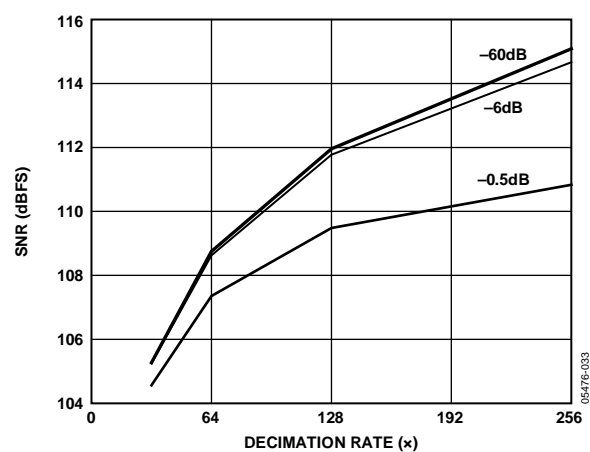


Figure 17. Low Power SNR vs. Decimation Rate, 1 kHz Input Tone

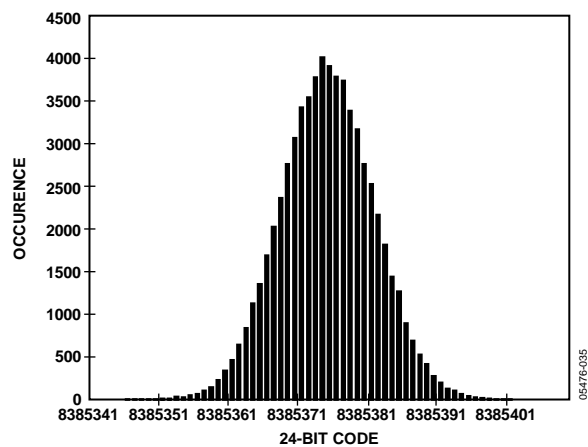


Figure 18. Normal Mode, 24-Bit Histogram, 256× Decimation

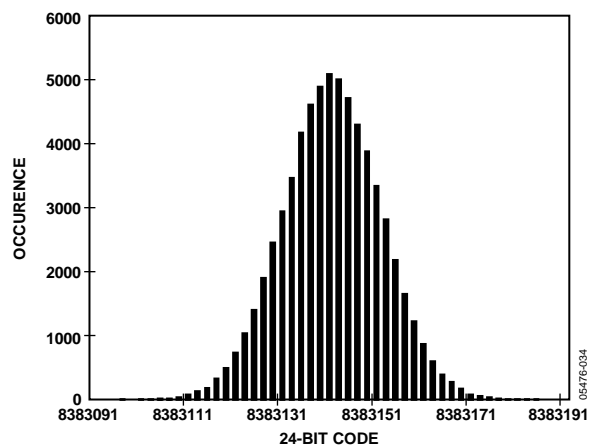


Figure 21. Low Power 24-Bit Histogram, 256× Decimation

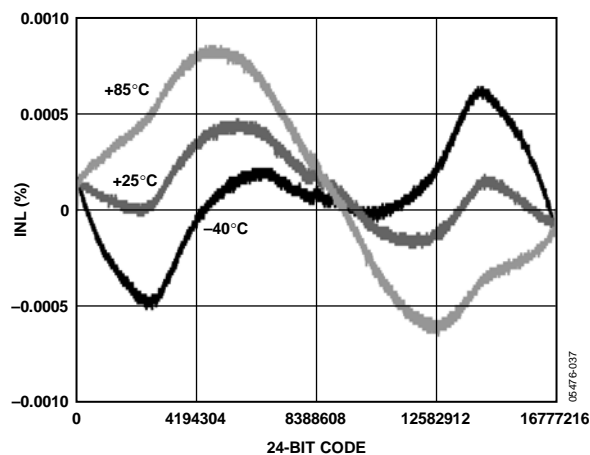


Figure 19. 24-Bit INL, Normal Power Mode

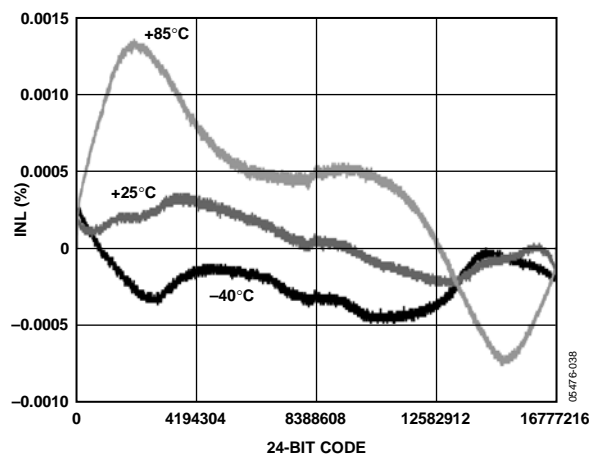


Figure 22. 24-Bit INL, Low Power Mode

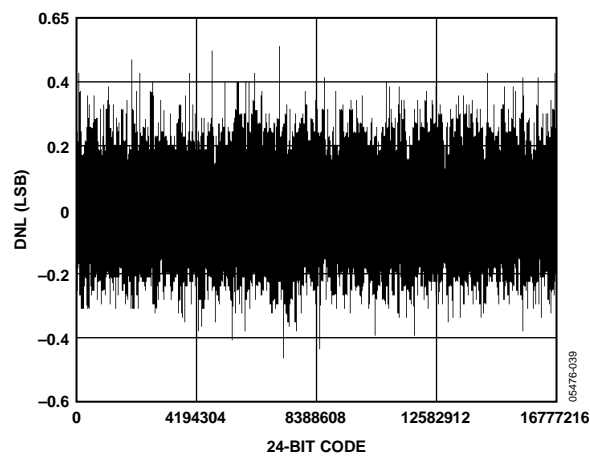


Figure 20. 24-Bit DNL

## THEORY OF OPERATION

The AD7763 employs a  $\Sigma$ - $\Delta$  conversion technique to convert the analog input into an equivalent digital word. The modulator samples the input waveform and outputs an equivalent digital word to the digital filter at a rate equal to ICLK.

Due to the high oversampling rate, which spreads the quantization noise from 0 to  $f_{\text{ICLK}}$ , the noise energy contained in the band of interest is reduced (see Figure 23). To further reduce quantization noise, a high order modulator is employed to shape the noise spectrum; thus, most of the noise energy is shifted out of the band of interest (see Figure 24).

The digital filtering that follows the modulator removes the large out-of-band quantization noise (see Figure 25), while also reducing the data rate from  $f_{\text{ICLK}}$  at the input of the filter to  $f_{\text{ICLK}}/32$  or less at the output of the filter, depending on the decimation rate used.

Digital filtering has certain advantages over analog filtering. It does not introduce significant noise or distortion and can be made perfectly linear phase.

The AD7763 employs three finite impulse response (FIR) filters in series. By using different combinations of decimation ratios and filter selection, data can be obtained from the AD7763 at four different data rates. The first filter receives data from the modulator at ICLK MHz, where it is decimated  $\times 4$  to output data at (ICLK/4) MHz.

The second filter allows the decimation rate to be chosen from  $8\times$  to  $32\times$ . The third filter has a fixed decimation rate of  $2\times$ , is user programmable, and has a default configuration (see the Programmable FIR Filter section). This filter can be bypassed.

Table 6 shows some characteristics of the default filter. The group delay of the filter is defined as the delay to the center of the impulse response and is equal to the computation plus filter delays. The delay until valid data is available (the DVALID status bit is set) is equal to  $2\times$  the filter delay plus the computation delay.

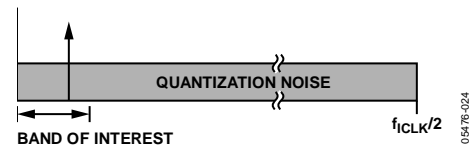


Figure 23.  $\Sigma$ - $\Delta$  ADC, Quantization Noise

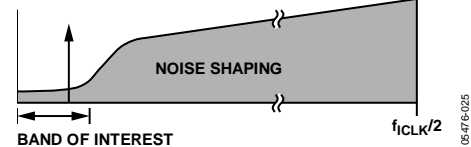


Figure 24.  $\Sigma$ - $\Delta$  ADC, Noise Shaping

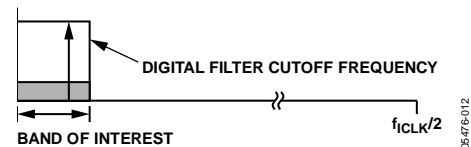


Figure 25.  $\Sigma$ - $\Delta$  ADC, Digital Filter Cutoff Frequency

Table 6. Configuration With Default Filter

| ICLK Frequency | Filter 1 | Filter 2 | Filter 3 | Data State         | Computation Delay | Filter Delay  | Pass Band Bandwidth | Output Data Rate (ODR) |
|----------------|----------|----------|----------|--------------------|-------------------|---------------|---------------------|------------------------|
| 20 MHz         | 4×       | 4×       | 2×       | Fully filtered     | 1.775 $\mu$ s     | 44.4 $\mu$ s  | 250 kHz             | 625 kHz                |
| 20 MHz         | 4×       | 8×       | Bypassed | Partially filtered | 2.6 $\mu$ s       | 10.8 $\mu$ s  | 140.625 kHz         | 625 kHz                |
| 20 MHz         | 4×       | 8×       | 2×       | Fully filtered     | 2.25 $\mu$ s      | 87.6 $\mu$ s  | 125 kHz             | 312.5 kHz              |
| 20 MHz         | 4×       | 16×      | Bypassed | Partially filtered | 4.175 $\mu$ s     | 20.4 $\mu$ s  | 70.3125 kHz         | 312.5 kHz              |
| 20 MHz         | 4×       | 16×      | 2×       | Fully filtered     | 3.1 $\mu$ s       | 174 $\mu$ s   | 62.5 kHz            | 156.25 kHz             |
| 20 MHz         | 4×       | 32×      | Bypassed | Partially filtered | 7.325 $\mu$ s     | 39.6 $\mu$ s  | 35.156 kHz          | 156.25 kHz             |
| 20 MHz         | 4×       | 32×      | 2×       | Fully filtered     | 4.65 $\mu$ s      | 346.8 $\mu$ s | 31.25 kHz           | 78.125 kHz             |
| 12.288 MHz     | 4×       | 8×       | 2×       | Fully filtered     | 3.66 $\mu$ s      | 142.6 $\mu$ s | 76.8 kHz            | 192 kHz                |
| 12.288 MHz     | 4×       | 16×      | 2×       | Fully filtered     | 5.05 $\mu$ s      | 283.2 $\mu$ s | 38.4 kHz            | 96 kHz                 |
| 12.288 MHz     | 4×       | 32×      | Bypassed | Partially filtered | 11.92 $\mu$ s     | 64.45 $\mu$ s | 21.6 kHz            | 96 kHz                 |
| 12.288 MHz     | 4×       | 32×      | 2×       | Fully filtered     | 7.57 $\mu$ s      | 564.5 $\mu$ s | 19.2 kHz            | 48 kHz                 |

## AD7763 INTERFACE

### READING DATA USING THE SPI INTERFACE

The timing diagram in Figure 2 shows how the AD7763 transmits its conversion results using the SPI-compatible serial interface.

The data being read from the AD7763 is clocked out using the serial clock output, SCO. The SCO frequency is dependent on the state of the serial clock output rate pin, SCR, and the clock divider mode chosen by the state of the clock divider pin, CDIV (see the Clocking the AD7763 section). Table 7 shows both the SCO frequency and the ICLK frequency for the AD7763, resulting from the states of both the CDIV and SCR pins.

**Table 7. SCO Frequency**

| Clock Divide Mode | CDIV | SCR | SCO Frequency     | ICLK Frequency |
|-------------------|------|-----|-------------------|----------------|
| Divide by 1       | 1    | 0   | MCLK              | MCLK           |
|                   |      | 1   | MCLK              | MCLK           |
| Divide by 2       | 0    | 0   | MCLK/2            | MCLK/2         |
|                   |      | 1   | MCLK <sup>1</sup> | MCLK/2         |

<sup>1</sup> In decimate  $\times 32$  mode, when CDIV = 0 and SCR = 1, FSO pulses low for 32 SCO clock cycles, as shown in Figure 2. For all other combinations of CDIV and SCR in decimate  $\times 32$  mode, FSO is continuously low.

An active low pulse of one SCO period on the data-ready output, DRDY, indicates a new conversion result is available at the AD7763 serial data output, SDO.

Each bit of the new conversion result is clocked onto the SDO line on the rising SCO edge and is valid on the falling SCO edge (for SCP = 0). The conversion result spans 32 SCO clock cycles and consists of 24 data bits in twos complement form, followed by 7 status bits.

| D6   | D5   | D4   | D3     | D2  | D1   | D0        |
|------|------|------|--------|-----|------|-----------|
| ADR2 | ADR1 | ADR0 | DVALID | OVR | LPWR | FILTER_OK |

The conversion result output on the SDO line is framed by the frame synchronization output, FSO, which is sent logic low for 32 SCO cycles following the rising edge of the DRDY signal. Note that the SDO line is in three-state for one clock cycle before the FSO signal returns to logic high, which means that only 31 actual data bits are output in each conversion.

The first three status bits, ADR[2:0], are the device address bits. The DVALID bit is asserted when the data being clocked out on the SDO line is valid. Table 19 contains descriptions of the other status bits: OVR, LPWR, and FILTER\_OK.

There is an exception to the behavior of FSO when the AD7763 operates in decimate  $\times 32$  mode (see Endnote 1 of Table 7). If SCR and CDIV are chosen so that the SCO frequency output has the capability to clock through only 32 SCO cycles before the MSB of the next conversion result is output, then FSO stays logic low continuously.

The AD7763 also features a serial data latch output, SDL, which outputs a pulse every 16 data bits. The SDL output offers an alternative framing signal for serial transfers, which require a framing signal more frequent than every 32 bits.

### SYNCHRONIZATION

The SYNC input to the AD7763 provides a synchronization function that allows the user to begin gathering samples of the analog front-end input from a known point in time.

The SYNC function allows multiple AD7763s, operated from the same master clock and using the same SYNC signal, to be synchronized so that each ADC simultaneously updates its output register.

Using a common SYNC signal to all AD7763 devices in a system allows synchronization to occur. On the falling edge of the SYNC signal, the digital filter sequencer is reset to 0. The filter is held in reset state until a rising edge of the SCO senses SYNC high. Thus, to perform a synchronization of devices, a SYNC pulse of a minimum of 2.5 ICLK cycles in length can be applied, synchronous to the falling edge of SCO. On the first rising edge of SCO after SYNC goes logic high, the filter is taken out of reset, and the multiple parts gather input samples synchronously.

Following a SYNC, the digital filter needs time to settle before valid data can be read from the AD7763. The user knows there is valid data on the SDO line by checking the DVALID status bit (see D3 in the status bits listing) that is output with each conversion result. The time from the rising edge of SYNC until the DVALID bit is asserted is dependent on the filter configuration used. See the Theory of Operation section and the figures listed in Table 6 for details on calculating the time until DVALID is asserted.

### SHARING THE SERIAL BUS

The AD7763 functionality allows up to eight devices to share the same serial bus, SDO, depending on the decimation rate that is chosen.

Table 8 details the maximum number of devices that can share the same SDO line for each decimation rate ( $\times 32$ ,  $\times 64$ ,  $\times 128$ ,  $\times 256$ ).

**Table 8. Maximum Number of Devices Sharing SDO**

|                                       |           | Decimation Rate |     |      |      |
|---------------------------------------|-----------|-----------------|-----|------|------|
|                                       | SCO (MHz) | ×32             | ×64 | ×128 | ×256 |
| Maximum Number of Devices Sharing SDO | 40        | 2               | 4   | 8    | 8    |
|                                       | 20        | N/A             | 2   | 4    | 8    |



The Share Pins SH[2:0] of all the devices sharing the serial bus must be programmed for the correct number of devices that are sharing the serial bus. A binary value of  $N - 1$  should be applied to the SH[2:0] bits, where  $N$  equals the number of devices in the chain. For example if there are 4 devices in the chain set SH[2:0] = 011.

Using the Address Pins ADR[2:0], all devices that share the serial bus are assigned binary addresses from 000 to 111 (depending on the number of devices in the share scheme). The address assigned to each device must not have a value greater than the number of devices sharing the serial bus. Thus,  $ADR[2:0] \leq SH[2:0]$ . This applies to all the devices that share the serial bus. Note also that each of the devices in the share scheme must have a different individual address.

For the device in the share scheme with an address of 000, the SDO line comes out of three-state on the first rising edge of SCO after the  $\overline{DRDY}$  pulse and returns to three-state 5.5 ns before the 31st SCO rising edge. For the next device sharing the serial bus, Address 001, the SDO line comes out of three-state on the 33rd SCO rising edge (that is, the first SCO rising edge of the next conversion output cycle). Thus, the SDO line goes into tri-state for one SCO cycle in between data being clocked onto SDO by two different devices that share the SDO line. This means that a bus contention issue is avoided. This pattern of behavior continues for the rest of the devices sharing the serial bus.

Each AD7763 device sharing the serial bus outputs its own  $\overline{FSO}$  signal.

Figure 26 shows an example of four devices sharing the same serial bus. All the devices in the share chain shown in Figure 26 operate in decimate  $\times 64$  mode (selected by writing to Control Register 1—Address 0x001) and use a maximum SCO signal of 40 MHz (see the Clocking the AD7763 section).

The Share Pins SH[2:0] of all the devices shown in Figure 26 are set to 011, corresponding to the four devices that are in the share configuration. Each AD7763 is hardwired with a different binary address ranging from 000 to 011, using the Address Pins ADR[2:0].

The timing diagram for the share configuration shown in Figure 26 is detailed in Figure 4. Device A outputs its 32-bit conversion result on the SDO line during the first 32 SCO cycles (as per the format shown in the Reading Data Using the SPI Interface section). Device B then outputs its conversion result during the next 32 SCO cycles, and so on for Device C and Device D. Note the way in which the SDO line is three-stated, separating data from each of the devices sharing the serial bus. The provision of two framing signals,  $\overline{DRDY}$  and  $\overline{FSO}$ , ensures that the AD7763 offers flexible data output framing options, which are further enhanced by the availability of the SDL output. The user can select the framing output that best suits the application.

## WRITING TO THE AD7763

Figure 3 shows the AD7763 write operation. The serial writing operation is synchronous to the SCO signal. The status of the frame sync input, FSI, is checked on the falling edge of the SCO signal. If the FSI line is low, then the first data is latched in on the next SCO falling edge.

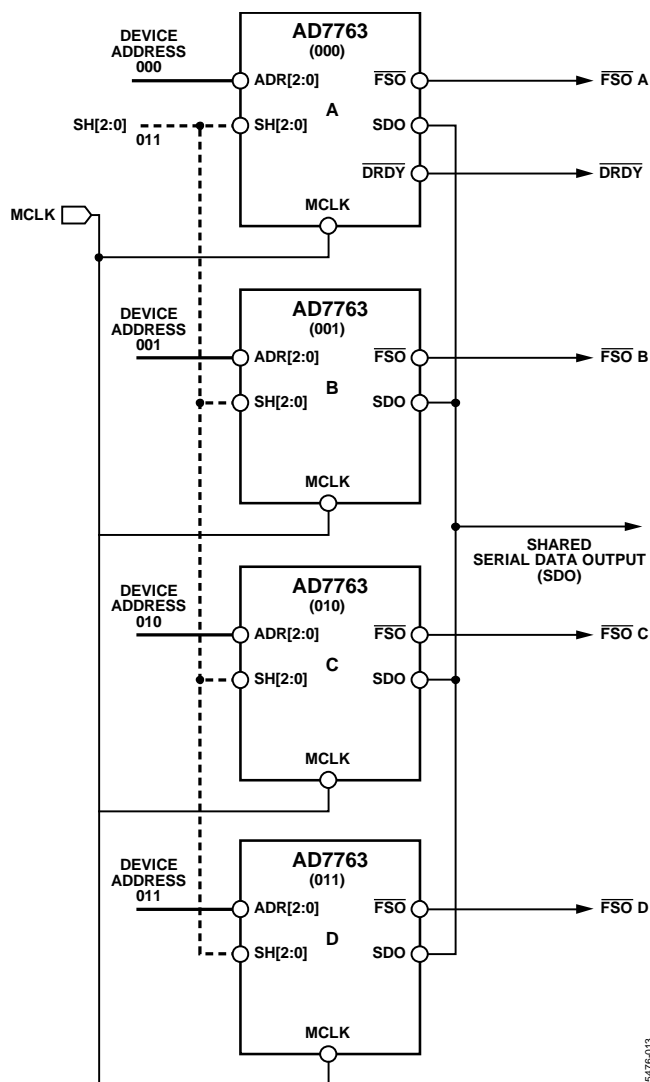


Figure 26. Four AD7763 Devices Sharing the Serial Bus

The active edge of the  $\overline{FSI}$  signal should be set to occur at a position when the SCO signal is high or low and which also allows setup and hold time from the SCO falling edge to be met. The width of the  $\overline{FSI}$  signal can be set to between 1 SCO period and 32 SCO periods wide. A second or subsequent FSI falling edge, which occurs before 32 SCO periods have elapsed, is ignored.

Figure 3 also shows the format for the serial data written to the AD7763. A write operation requires 32 bits. The first 16 bits select the device and register address for which the data written is intended. The second 16 bits contain the data for the selected register. When using multiple devices that share the same serial bus,

all  $\overline{\text{FSO}}$  and SDI pins can be tied together and each device written to individually by setting the appropriate address bits in the serial 32-bit word. The exception to this is when all devices can be written to at the same time by setting the ALL bit to logic high.

Thus, if this bit is set to logic high, every device on the serial bus accepts the data written, regardless of the address bits. This feature is particularly attractive if, for example, four devices are being configured with the same user-defined filter. Instead of having to download the filter configuration four times, only one write is required. See the Downloading a User-Defined Filter section for further details.

Writing to AD7763 is allowed at any time, even while reading a conversion result. Note that after writing to the devices, valid data is not output until after the settling time for the filter has elapsed. The DVALID status bit is asserted at this point to indicate that the filter has settled and that valid data is available at the output.

## READING STATUS AND OTHER REGISTERS

The AD7763 features a number of programmable registers. To read back the contents of these registers or the status register, the user must first write to the control register of the device, setting a bit corresponding to the register to be read. The next read operation then outputs the contents of the selected register instead of a conversion result.

To ensure that the next read cycle contains the contents of the register that has been written to, the write operation to the register in question must be completed a minimum of  $8 \times t_{\text{SCO}}$  before the falling edge of  $\overline{\text{DRDY}}$ , which indicates the start of the next read cycle.

More information on the relevant bits in the control register is provided in the Registers section.

## READING DATA USING THE I<sup>2</sup>S INTERFACE

The AD7763 has the capability of operating using an I<sup>2</sup>S interface. The interface is functional only for the output of stereo data and does not apply to writing to control registers, programming coefficients for the digital filter, or the reading of any information contained in the AD7763 onboard registers. All of these operations must be undertaken using the normal serial interface.

The I<sup>2</sup>S interface operates using two AD7763 devices. The pins shown in Table 9 are used as the output pins for the SCK (serial clock), SD (serial data), and WS (word select) signals for the I<sup>2</sup>S interface.

Table 9.

| SPI Pins | I <sup>2</sup> S Signals |
|----------|--------------------------|
| FSO      | WS                       |
| SDO      | SD                       |
| SCO      | SCK                      |

To enable the I<sup>2</sup>S interface, the I<sup>2</sup>S pin is set to logic high. The Share Pins SH[2:0] of both AD7763 devices that use the I<sup>2</sup>S interface are set to 001. The Address Pins ADR[2:0] of the two devices must also be set to 000 and 001, respectively.

The WS and SCK signals that are used for the interface can be taken from either AD7763 device. Note that the device that is assigned Address 000 is defined as the left channel, and its data is output on the SD line when WS is logic low.

The WS and SCK signals can be taken from the appropriate pins on either of the AD7763 devices using the I<sup>2</sup>S interface. The SD pins of both devices must be connected together, as shown in Figure 27.

Data is clocked out on the SD line in accordance with Figure 28. Because Device A is assigned Address 000, it is defined as the left channel. The 32-bit conversion result from the left channel is clocked out when WS is logic low, with the MSB being clocked out first. Each 32-bit result consists of 24 data bits in twos complement format, followed by eight status bits, as shown in the following bit map.

| D7     | D6  | D5      | D4   | D3        | D2   | D1 | D0          |
|--------|-----|---------|------|-----------|------|----|-------------|
| DVALID | OVR | UFILTER | LPWR | FILTER_OK | ADRO | 0  | Three-State |

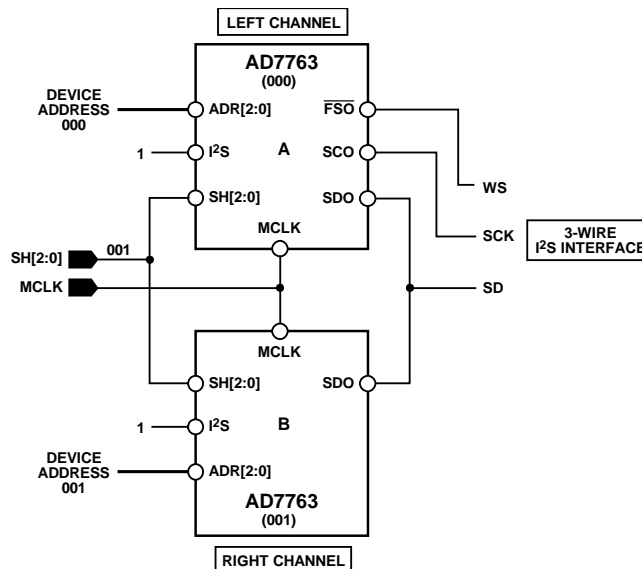


Figure 27. Two AD7763 Devices Operating Using the I<sup>2</sup>S Interface

Conversion results from Device B, assigned Address 001, are clocked out on the SD line when WS is logic high. The SD line goes into three-state on the falling edge of the 32nd SCK after the falling edge of WS (left channel data) and also on the falling edge of the 32nd SCK after the rising edge of WS (right channel data). This permits swapping of the SD bus between the left and right channel devices without contention.

In decimate  $\times 32$  mode the I<sup>2</sup>S interface is operational only when  $\overline{\text{CDIV}} = 0$  and  $\text{SCR} = 1$ . The interface operates for all combinations of SCR and  $\overline{\text{CDIV}}$  in all other modes of decimation.

The  $\overline{\text{DRDY}}$  pulse still operates as in the normal serial SPI-type interface, pulsing low immediately prior to the falling edge of WS but having no meaning in the I<sup>2</sup>S interface specification.

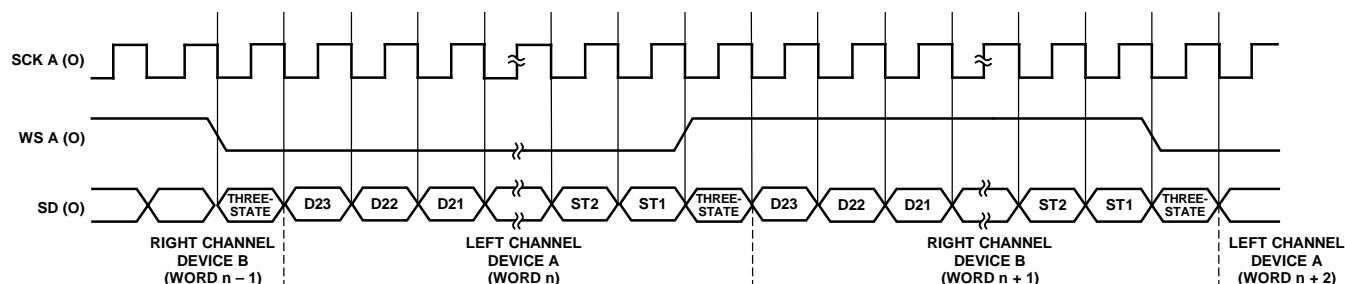


Figure 28. Timing Diagram for I<sup>2</sup>S Interface

## CLOCKING THE AD7763

The AD7763 requires an external, low jitter clock source. This signal is applied to the MCLK pin, and the MCLKGND pin is used to sense the ground from the clock source. An internal clock signal (ICLK) is derived from the MCLK input signal. The ICLK controls the internal operations of the AD7763. The maximum ICLK frequency is 20 MHz, but due to an internal clock divider, a range of MCLK frequencies can be used. There are two ways to generate the ICLK:

$$ICLK = MCLK (\overline{CDIV} = 1)$$

$$ICLK = MCLK/2 (\overline{CDIV} = 0)$$

This option is pin selectable (Pin 58). On power-up, the default is  $ICLK = MCLK/2$  to ensure that the part can handle the maximum MCLK frequency of 40 MHz. For output data rates equal to those used in audio systems, a 12.288 MHz ICLK frequency can be used. As shown in Table 6, output data rates of 192 kHz, 96 kHz, and 48 kHz are achievable with this ICLK frequency. As mentioned previously, this ICLK frequency can be derived from different MCLK frequencies.

The MCLK jitter requirements depend on a number of factors and are determined by

$$t_{j(rms)} = \frac{\sqrt{OSR}}{2 \times \pi \times f_{IN} \times 10^{\frac{SNR(dB)}{20}}}$$

Where:

$$OSR = \text{oversampling ratio} = \frac{f_{ICLK}}{ODR}$$

$f_{IN}$  = maximum input frequency.

$SNR(dB)$  = target SNR.

### EXAMPLE 1

This example is taken from Table 6, where:

$$ODR = 625 \text{ kHz.}$$

$$f_{ICLK} = 20 \text{ MHz.}$$

$$f_{IN} (\text{maximum}) = 250 \text{ kHz.}$$

$$SNR = 108 \text{ dB.}$$

$$t_{j(rms)} = \frac{\sqrt{32}}{2 \times \pi \times 250 \times 10^3 \times 10^6} = 3.6 \text{ ps}$$

This is the maximum allowable clock jitter for a full-scale, 250 kHz input tone with the given ICLK and output data rate.

### EXAMPLE 2

Following is a second example from Table 6, where:

$$ODR = 48 \text{ kHz.}$$

$$f_{ICLK} = 12.288 \text{ MHz.}$$

$$f_{IN} (\text{maximum}) = 19.2 \text{ kHz.}$$

$$SNR = 120 \text{ dB.}$$

$$t_{j(rms)} = \frac{\sqrt{256}}{2 \times \pi \times 19.2 \times 10^3 \times 10^6} = 133 \text{ ps}$$

The input amplitude also has an effect on these jitter figures. If, for example, the input level is 3 dB below full scale, the allowable jitter is increased by a factor of  $\sqrt{2}$ , increasing the first example to 2.53 ps rms. This happens when the maximum slew rate is decreased by a reduction in amplitude. Figure 29 and Figure 30 illustrate this point, showing the maximum slew rate of a sine wave of the same frequency but with different amplitudes.

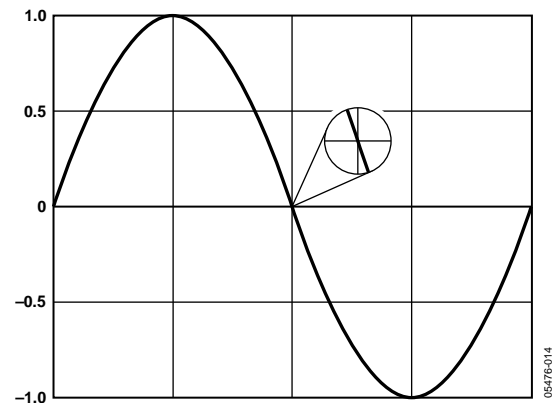


Figure 29. Maximum Slew Rate of Sine Wave with Amplitude of 2 V p-p

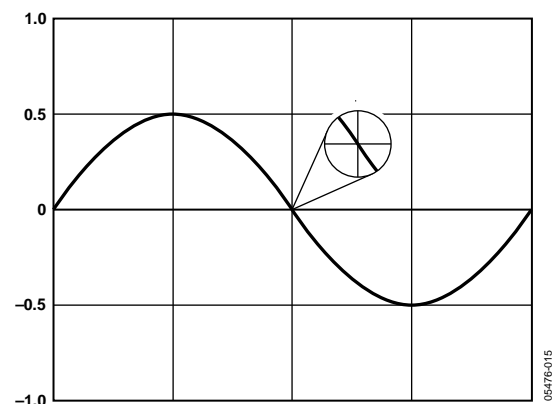


Figure 30. Maximum Slew Rate of Same Frequency Sine Wave with Amplitude of 1 V p-p

## DRIVING THE AD7763

The AD7763 has an on-chip differential amplifier that operates with a supply voltage ( $AV_{DD3}$ ) from 3.15 V to 5.25 V. For a 4.096 V reference, the supply voltage must be 5 V.

To achieve the specified performance in normal mode, the differential amplifier should be configured as a first-order antialias filter, as shown in Figure 31. Any additional filtering should be carried out in previous stages using low noise, high performance op amps, such as the AD8021.

Suitable component values for the first-order filter are shown in Table 10. The values in Table 10 yield a 10 dB attenuation at the first alias point of 19 MHz.

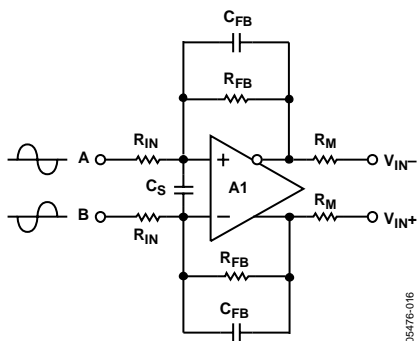


Figure 31. Differential Amplifier Configuration

Table 10. Normal Mode Component Values

| $V_{REF}$ | $R_{IN}$     | $R_{FB}$     | $R_M$       | $C_S$  | $C_{FB}$ |
|-----------|--------------|--------------|-------------|--------|----------|
| 4.096 V   | 1 k $\Omega$ | 655 $\Omega$ | 18 $\Omega$ | 5.6 pF | 33 pF    |

Figure 32 shows the signal conditioning that occurs using the circuit in Figure 18 with a  $\pm 2.5$  V input signal biased around ground and having the component values and conditions in Table 10.

The differential amplifier always biases the output signal to sit on the optimum common mode of  $V_{REF}/2$ , in this case, 2.048 V. The signal is also scaled to give the maximum allowable voltage swing with this reference value. This is calculated as 80% of  $V_{REF}$ ; that is,  $0.8 \times 4.096 \text{ V} \approx 3.275 \text{ V p-p}$  on each input.

To obtain maximum performance from the AD7763, it is advisable to drive the ADC with differential signals. Figure 33 shows how a bipolar, single-ended signal biased around ground can drive the AD7763 with the use of an external op amp, such as the AD8021.

With a 4.096 V reference, a 5 V supply must be provided to the reference buffer ( $AV_{DD4}$ ). With a 2.5 V reference, a 3.3 V supply must be provided to  $AV_{DD4}$ .

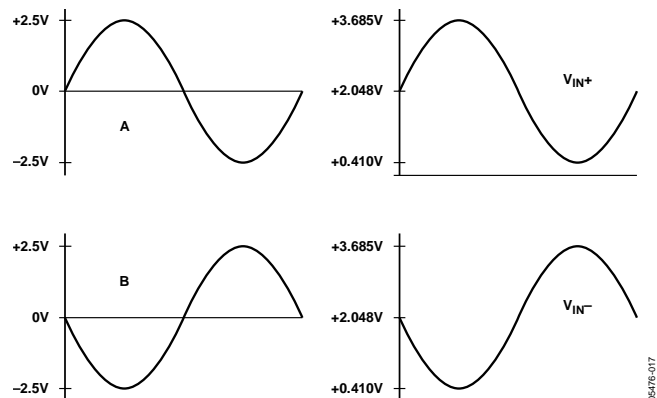


Figure 32. Differential Amplifier Signal Conditioning

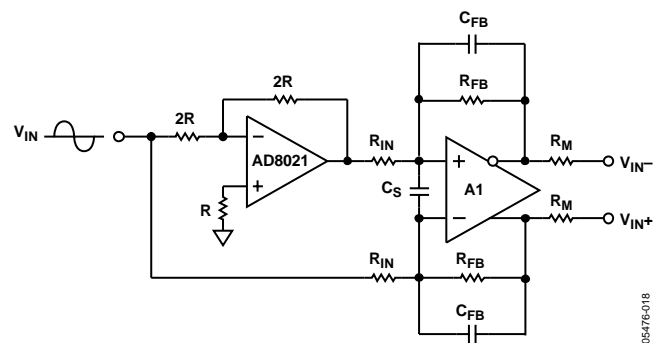


Figure 33. Single-Ended-to-Differential Conversion

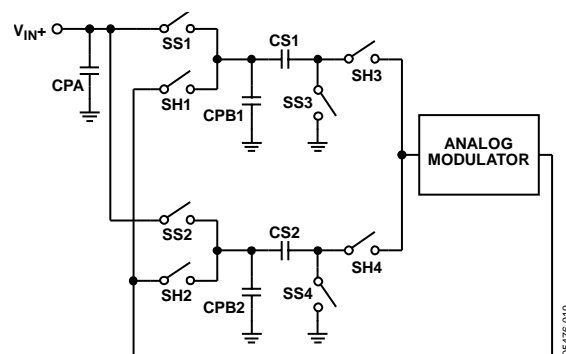


Figure 34. Equivalent Input Circuit

The AD7763 employs a double sampling front end, as shown in Figure 34. For simplicity, only the equivalent input circuit for  $V_{IN+}$  is shown. The equivalent input circuitry for  $V_{IN-}$  is the same.

Sampling Switch SS1 and Sampling Switch SS3 are driven by ICLK, whereas Sampling Switch SS2 and Sampling Switch SS4 are driven by ICLK. When ICLK is high, the analog input voltage is connected to CS1. On the falling edge of ICLK, the SS1 and SS3 switches open, and the analog input is sampled on CS1. Similarly, when ICLK is low, the analog input voltage is connected to CS2. On the rising edge of ICLK, the SS2 and SS4 switches open, and the analog input is sampled on CS2.

Capacitor CPA, Capacitor CPB1, and Capacitor CPB2 represent parasitic capacitances that include the junction capacitances associated with the MOS switches.

**Table 11. Equivalent Component Values**

| Mode      | CS1   | CS2   | CPA   | CPB1/CPB2 |
|-----------|-------|-------|-------|-----------|
| Normal    | 51 pF | 51 pF | 12 pF | 20 pF     |
| Low Power | 13 pF | 13 pF | 12 pF | 5 pF      |

## USING THE AD7763

Following is the recommended sequence for powering up and using the AD7763.

1. Apply power.
2. Start clock oscillator, applying MCLK.
3. Take  $\overline{\text{RESET}}$  low for a minimum of 1 MCLK cycle.
4. Wait a minimum of 2 MCLK cycles after  $\overline{\text{RESET}}$  has been released.
5. Write to Control Register 2 to power up the ADC and the differential amplifier, as required.
6. Write to Control Register 1 to set up the output data rate.
7. In circumstances where multiple parts are being synchronized, a SYNC pulse must be applied to the parts; otherwise, no SYNC pulse is required.

The following are conditions for applying the  $\overline{\text{SYNC}}$  pulse:

- The issuing of a  $\overline{\text{SYNC}}$  pulse to the part must not coincide with a write to the part.
- The  $\overline{\text{SYNC}}$  pulse should be applied a minimum of 2.5 ICLK cycles after the FSI signal for the previous write to the part has returned to logic high.
- Ensure that the  $\overline{\text{SYNC}}$  pulse is taken low for a minimum of 2.5 ICLK cycles.

Data can now be read from the part using the default filter, offset, gain, and overrange threshold values. The conversion data read is not valid, however, until the settling time of the filter has passed. When this has occurred, the DVALID bit read is set, indicating that the data is indeed valid.

The user can then download a user-defined filter, if required (see Downloading a User-Defined Filter). Values for gain, offset, and overrange threshold registers can also be written or read at this stage.

## BIAS RESISTOR SELECTION

The AD7763 requires a resistor to be connected between the R<sub>BIAS</sub> pin and AGND. The value for this resistor is dependent on the reference voltage being applied to the device. The resistor value should be selected to give a current of 25  $\mu\text{A}$  through the resistor to ground. For a 2.5 V reference voltage, the correct resistor value is 100 k $\Omega$ ; for a 4.096 V reference voltage, the correct resistor value is 160 k $\Omega$ .

## DECOUPLING AND LAYOUT RECOMMENDATIONS

Due to the high performance nature of the [AD7763](#), correct decoupling and layout techniques are required to obtain the performance as stated within this data sheet. Figure 35 shows a simplified connection diagram for the [AD7763](#).

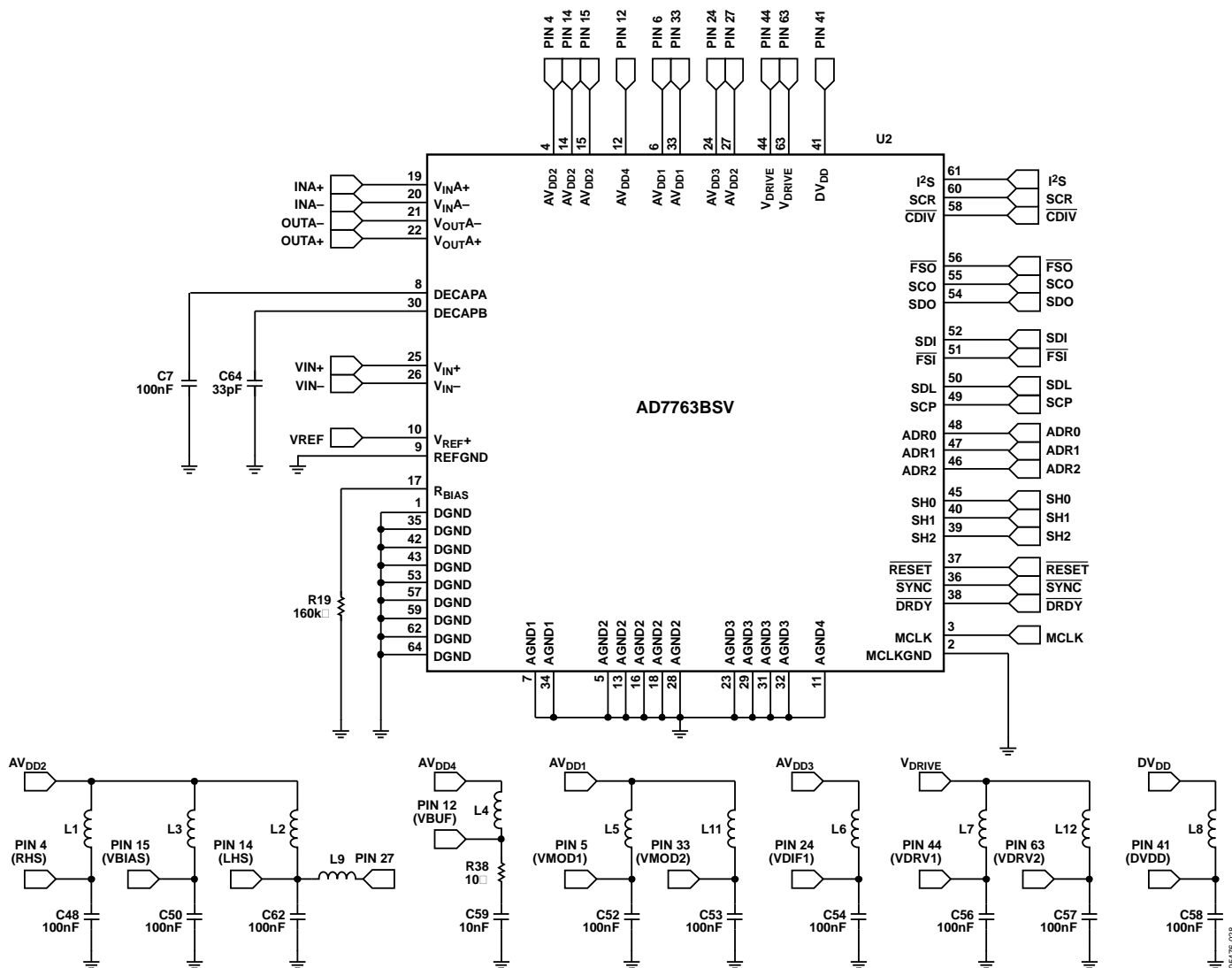


Figure 35. Simplified Connection Diagram

## SUPPLY DECOUPLING

Every supply pin must be connected to the appropriate supply via a ferrite bead and decoupled to the correct ground pin with a 100 nF, 0603 case size, X7R dielectric capacitor. There are two exceptions

- Pin 12 ( $AV_{DD4}$ ) must have a 10  $\Omega$  resistor inserted between the pin and a 10 nF decoupling capacitor.
- Pin 27 ( $AV_{DD2}$ ) does not require a separate decoupling capacitor or a direct connection to the supply; instead, it is connected to Pin 14 via an 8.2 nH inductor.

The ferrite beads that are used to connect each supply pin to the appropriate power supply should have a characteristic impedance of 600  $\Omega$  to 1 M $\Omega$  at frequencies around 100 MHz, a dc impedance of 1  $\Omega$  or less, and a rated current of 200 mA.

## ADDITIONAL DECOUPLING

There are two other decoupling pins on the AD7763: Pin 8 (DECAPA) and Pin 30 (DECAPB). Pin 8 should be decoupled with a 100 nF capacitor, and Pin 30 requires a 33 pF capacitor.

## REFERENCE VOLTAGE FILTERING

A low noise reference source, such as the ADR431 (2.5 V) or ADR434 (4.096 V), is suitable for use with the AD7763. The reference voltage supplied to the AD7763 should be decoupled and filtered, as shown in Figure 36.

The recommended scheme for the reference voltage supply is a 100  $\Omega$  series resistor connected to a 100  $\mu$ F tantalum capacitor, followed by a series resistor of 10  $\Omega$ , and finally, a 10 nF decoupling capacitor very close to the  $V_{REF}$  pin.

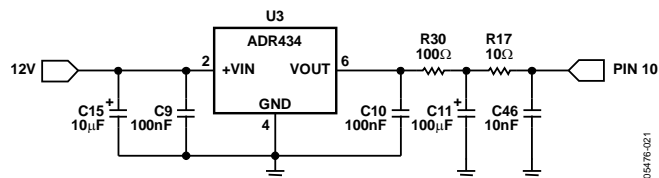


Figure 36. Reference Connection

## DIFFERENTIAL AMPLIFIER COMPONENTS

The correct components for use around the on-chip differential amplifier are shown in Table 10. Matching the components on both sides of the differential amplifier is important to minimize distortion of the signal applied to the amplifier. A tolerance of 0.1% or better is required for these components. Symmetrical routing of the tracks on both sides of the differential amplifier also assists in achieving stated performance.

## EXPOSED PADDLE

The AD7763 64-lead TQFP\_EP employs a 6 mm × 6 mm exposed paddle (see Figure 39). The paddle reduces the thermal resistance of the package by providing a path of low thermal resistance to the PCB and, in turn, increases the heat transfer efficiency from the AD7763 package. Soldering the exposed paddle to the AGND plane of the PCB is fundamental in creating the conditions that allow the AD7763 package to perform to the highest specifications possible.

## LAYOUT CONSIDERATIONS

While using the correct components is essential to achieve optimum performance, the correct layout is just as important. The *Design Tools* section of the AD7763 product page on the Analog Devices website contains the Gerber files for the AD7763 evaluation board. These files should be used as a reference when designing any system using the AD7763.

The location and orientation of some of the components mentioned in previous sections are critical, and particular attention must be paid to the components that are located close to the AD7763. Locating these components farther away from the devices can have a direct impact on the maximum performance achievable.

The use of ground planes should also be carefully considered. To ensure that the return currents through the decoupling capacitors are flowing to the correct ground pin, the ground side of the capacitors should be as close as possible to the ground pin associated with that supply. A ground plane should not be relied upon as the sole return path for decoupling capacitors, because the return current path using ground planes is not easily predicted.



## PROGRAMMABLE FIR FILTER

As discussed in the Theory of Operation section, the third FIR filter on the AD7763 can be programmed by the user. The default coefficients that are loaded on reset are shown in Table 12. This gives the frequency response shown in Figure 37. The frequencies shown in Figure 37 scale directly with the output data rate.

**Table 12. Default Filter Coefficients**

| #  | Decimal Value | Hex Value | #  | Decimal Value | Hex Value |
|----|---------------|-----------|----|---------------|-----------|
| 0  | +53656736     | 332BCA0   | 24 | +700847       | AB1AF     |
| 1  | +25142688     | 17FA5A0   | 25 | -70922        | 401150A   |
| 2  | -4497814      | 444A196   | 26 | -583959       | 408E917   |
| 3  | -11935847     | 4B62067   | 27 | -175934       | 402AF3E   |
| 4  | -1313841      | 4140C31   | 28 | +388667       | 5EE3B     |
| 5  | +6976334      | 6A734E    | 29 | +294000       | 47C70     |
| 6  | +3268059      | 31DDDB    | 30 | -183250       | 402CBD2   |
| 7  | -3794610      | 439E6B2   | 31 | -302597       | 4049E05   |
| 8  | -3747402      | 4392E4A   | 32 | +16034        | 3EA2      |
| 9  | +1509849      | 1709D9    | 33 | +238315       | 3A2EB     |
| 10 | +3428088      | 344EF8    | 34 | +88266        | 158CA     |
| 11 | +80255        | 1397F     | 35 | -143205       | 4022F65   |
| 12 | -2672124      | 428C5FC   | 36 | -128919       | 401F797   |
| 13 | -1056628      | 4101F74   | 37 | +51794        | CA52      |
| 14 | +1741563      | 1A92FB    | 38 | +121875       | 1DC13     |
| 15 | +1502200      | 16EBF8    | 39 | +16426        | 402A      |
| 16 | -835960       | 40CC178   | 40 | -90524        | 401619C   |
| 17 | -1528400      | 4175250   | 41 | -63899        | 400F99B   |
| 18 | +93626        | 16DBA     | 42 | +45234        | B0B2      |
| 19 | +1269502      | 135EFE    | 43 | +114720       | 1C020     |
| 20 | +411245       | 6466D     | 44 | +102357       | 18FD5     |
| 21 | -864038       | 40D2F26   | 45 | +52669        | CDBD      |
| 22 | -664622       | 40A242E   | 46 | +15559        | 3CC7      |
| 23 | +434489       | 6A139     | 47 | +1963         | 7AB       |

The default filter should be sufficient for most applications. It is a standard brick wall filter with a symmetrical impulse response. The default filter has a length of 96 taps and is nonaliasing, with 120 dB of attenuation at Nyquist. This filter not only performs signal antialiasing but also suppresses out-of-band quantization noise produced by the analog-to-digital conversion process. Any significant relaxation in the stop-band attenuation or transition bandwidth relative to the default filter can result in failure to meet the SNR specifications.

To create a user-defined filter, note the following:

- The filter must be even, symmetrical FIR.
- The coefficients are 27 bits in length. All coefficients are in sign-and-magnitude format. The sign bit coded as positive = 0 is followed by 26 magnitude bits.
- The filter length must be between 12 taps and 96 taps in steps of 12.
- Because the filter is symmetrical, the number of coefficients that must be downloaded is half the filter length. The default filter coefficients are an example of this, with only 48 coefficients listed for a 96-tap filter.
- Coefficients are written from the center of impulse response (adjacent to the point of symmetry) outward.
- The coefficients are scaled so that the in-band gain of the filter is equal to 134217726, with the coefficients rounded to the nearest integer. For a low-pass filter, this is the equivalent of having the coefficients sum arithmetically (including sign) to +67108863 (0x3FFFFFFF) positive value over the half-impulse-response coefficient set (maximum 48 coefficients). Any deviation from this results in the introduction of a gain error.

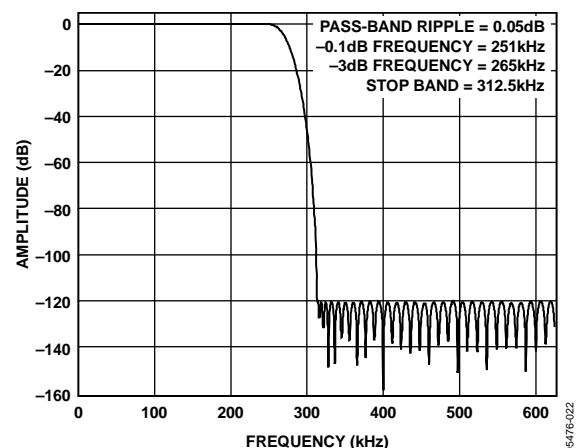


Figure 37. Default Filter Frequency Response (625 kHz ODR)

To download a user-defined filter, see the Downloading a User-Defined Filter section.

## DOWNLOADING A USER-DEFINED FILTER

As discussed in the Programmable FIR Filter section, each of the filter coefficients is 27 bits in length: one sign bit and 26 magnitude bits. To download coefficients for a user-specific FIR filter, a 32-bit word is written to the [AD7763](#) for each coefficient.

| D31 | D30  | D29  | D28  | D27 | D26  | D[25:0]   |
|-----|------|------|------|-----|------|-----------|
| ALL | ADR2 | ADR1 | ADR0 | 0   | Sign | Magnitude |

When a user writes coefficients to one device, the address of that particular device (as assigned by the ADR[2:0] pins) must be specified in the bits labeled ADR[2:0].

In a configuration where more than one device shares the same SDI line, setting the ALL bit to logic high and leaving Address Bits ADR[2:0] logic low enables the user to write each coefficient to all devices simultaneously.

To ensure that a filter is downloaded correctly, a checksum must be generated and downloaded following the download of the final coefficient. The checksum is a 16-bit word generated by splitting each 32-bit word into 4 bytes and summing all bytes from all coefficients up to a maximum of 192 bytes (maximum number of coefficients = 48 bytes × 4 bytes written for each coefficient).

The checksum is written to the device in the form of a 32-bit word in the following format:

| D31 | D30  | D29  | D28  | D[27:16] | D[15:0]  |
|-----|------|------|------|----------|----------|
| ALL | ADR2 | ADR1 | ADR0 | 0        | Checksum |

Note that when writing the checksum, the addressing requirements are as before, and Bit 27 to Bit 16 are all set to 0.

The same checksum is generated internally in the [AD7763](#) and compared with the checksum downloaded. The DL\_OK bit in the status register is set if these two checksums agree.

To download a user-defined filter:

1. Write to Control Register 1, setting the DL Filt bit. The correct Filter Length Bits FLEN[3:0] correspond to the length of the filter about to be downloaded (see Table 13) and the correct decimation rate.
2. Write the 32-bit word (as per format specified). The first coefficient to be written must be the one adjacent to the point of filter symmetry.
3. Repeat Step 2 for each coefficient.
4. Implement the checksum write as per the specified format.
5. Use the following methods to verify that the filter coefficients have been downloaded correctly:
  - Read the status register, checking the DL\_OK bit.
  - Start reading data and observe the status of the DL\_OK bit.

Note that because the user coefficients are stored in RAM, they are cleared after a RESET operation or a loss of power.

**Table 13. Filter Length Values**

| FLEN[3:0] | Number of Coefficients | Filter Length |
|-----------|------------------------|---------------|
| 0000      | Default                | Default       |
| 0001      | 6                      | 12            |
| 0011      | 12                     | 24            |
| 0101      | 18                     | 36            |
| 0111      | 24                     | 48            |
| 1001      | 30                     | 60            |
| 1011      | 36                     | 72            |
| 1101      | 42                     | 84            |
| 1111      | 48                     | 96            |

### EXAMPLE FILTER DOWNLOAD

The following is an example of downloading a short, user-defined filter with 24 taps. The frequency response is shown in Figure 38.

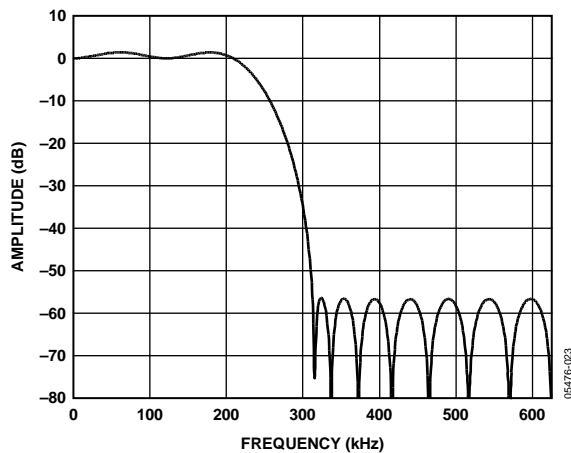


Figure 38. 24-Tap FIR Frequency Response

The coefficients for the filter in Table 14 are shown from the center of symmetry outward; that is, Coefficient 1 is the coefficient at the center of symmetry. The raw coefficients were generated using a commercial filter design tool and scaled appropriately so their sum equals 67108863 (0x3FF FFFF).

Table 14. 24-Tap FIR Coefficients

| Coefficient | Raw          | Scaled    |
|-------------|--------------|-----------|
| 1           | +0.365481974 | +53188232 |
| 2           | +0.201339905 | +29300796 |
| 3           | +0.009636604 | +1402406  |
| 4           | -0.075708848 | -11017834 |
| 5           | -0.042856209 | -6236822  |
| 6           | +0.019944246 | +2902466  |
| 7           | +0.036437914 | +5302774  |
| 8           | +0.007592007 | +1104856  |
| 9           | -0.021556583 | -3137108  |
| 10          | -0.024888355 | -3621978  |
| 11          | -0.012379538 | -1801582  |
| 12          | -0.001905756 | -277343   |

Table 15 shows the 32-bit word (as per the format shown in the Downloading a User-Defined Filter section) in hexadecimal for each of the coefficients that must be written to the AD7763 to realize this filter. The table is also split into the bytes that are all summed to produce the checksum. The checksum generated from these coefficients is 0x0E6B.

Table 15. Filter Hex Values<sup>1</sup>

| Coefficient | 32-Bit Word Written to Download Coefficient |        |        |        |
|-------------|---|--------|--------|--------|
|             | Byte 1                                      | Byte 2 | Byte 3 | Byte 4 |
| 1           | 03  | 2B     | 96     | 88     |
| 2           | 01  | BF     | 18     | 3C     |
| 3           | 00  | 15     | 66     | 26     |
| 4           | 04  | A8     | 1E     | 6A     |
| 5           | 04  | 5F     | 2A     | 96     |
| 6           | 00  | 2C     | 49     | C2     |
| 7           | 00  | 50     | E9     | F6     |
| 8           | 00  | 10     | DB     | D8     |
| 9           | 04  | 2F     | DE     | 54     |
| 10          | 04  | 37     | 44     | 5A     |
| 11          | 04  | 1B     | 7D     | 6E     |
| 12          | 04  | 04     | 3B     | 5F     |

<sup>1</sup> All values of words listed are with reference to writing to one device only (ALL = 0) with Address 000 (as assigned to the device using the ADR[2:0] pins).

Table 16 lists in hexadecimal format the sequence of 32-bit words the user writes to the AD7763 to set up the ADC and download this filter, assuming selection of an output data rate of 625 kHz.

Table 16.

| Word <sup>1</sup> | Description  |
|-------------------|--|
| 0x0001807A        | Address of Control Register 1. Control register data. DL filter, set filter length = 24, set output data rate = 625 kHz.   |
| 0x032B9688        | First coefficient.   |
| 0x01BF183C        | Second coefficient.  |
| ...               | Other coefficients.  |
| 0x04043B5F        | Twelfth (final) coefficient.   |
| 0x00000E6B        | Checksum. Wait $(0.5 \times t_{CLK} \times \text{number of unused coefficients})$ for AD7763 to fill remaining unused coefficients with 0s.  |
| 0x0001087A        | Address of Control Register. Control register data. Set read status and maintain filter length and decimation settings. Read contents of status register. Check Bit 7 (DL_OK) to determine that the filter downloaded correctly. |

<sup>1</sup> All values of words listed are with reference to writing to one device only (ALL = 0) with Address 000 (as assigned to the device using the ADR[2:0] pins).

## REGISTERS

The AD7763 has a number of user-programmable registers. The control registers are used to set the decimation rate, the filter configuration, the low power option, and the control of the differential amplifier. There are also digital gain, offset, and overrange threshold registers.

Writing to these registers involves writing the register address first, followed by a 16-bit data-word. Register addresses, details of individual bits, and default values are shown here.

### CONTROL REGISTER 1—ADDRESS 0X001

**Default Value 0x001A**

MSB

LSB

|         |        |         |        |         |   |      |       |       |       |       |        |   |      |      |      |
|---------|--------|---------|--------|---------|---|------|-------|-------|-------|-------|--------|---|------|------|------|
| DL Filt | RD Ovr | RD Gain | RD Off | RD Stat | 0 | SYNC | FLEN3 | FLEN2 | FLEN1 | FLEN0 | BYP F3 | 1 | DEC2 | DEC1 | DEC0 |
|---------|--------|---------|--------|---------|---|------|-------|-------|-------|-------|--------|---|------|------|------|

Table 17.

| Bit    | Mnemonic                | Comment  |
|--------|-------------------------|--|
| 15     | DL Filt <sup>1</sup>    | Download Filter. Before downloading a user-defined filter, this bit must be set. The filter length bits must also be set at this time. The write operations that follow are interpreted as the user coefficients for the FIR filter until all the coefficients and the checksum have been written. |
| 14     | RD Ovr <sup>1, 2</sup>  | Read Overrange. If this bit is set, the next read operation outputs the contents of the overrange threshold register instead of a conversion result.   |
| 13     | RD Gain <sup>1, 2</sup> | Read Gain. If this bit is set, the next read operation outputs the contents of the digital gain register.  |
| 12     | RD Off <sup>1, 2</sup>  | Read Offset. If this bit is set, the next read operation outputs the contents of the digital offset register.  |
| 11     | RD Stat <sup>1, 2</sup> | Read Status. If this bit is set, the next read operation outputs the contents of the status register.  |
| 10     | 0                       | 0 must be written to this bit.   |
| 9      | SYNC <sup>1</sup>       | Synchronize. Setting this bit initiates an internal synchronization routine. Setting this bit simultaneously on multiple devices synchronizes all filters.   |
| 8 to 5 | FLEN[3:0]               | Filter Length Bits. These bits must be set when the DL Filt bit is set and before a user-defined filter is downloaded.   |
| 4      | BYP F3                  | Bypass Filter 3. If this bit is a 0, Filter 3 (programmable FIR) is bypassed.  |
| 3      | 1                       | 1 must be written to this bit.   |
| 2 to 0 | DEC[2:0]                | Decimation Rate. These bits set the decimation rate of Filter 2. Writing a value of 0, 1, or 2 corresponds to 4× decimation. A value of 3 corresponds to 8× decimation; a value of 4 corresponds to 16×; and the maximum value of 5 corresponds to 32× decimation.                                 |

<sup>1</sup> Bit 15 to Bit 9 are all self-clearing bits.

<sup>2</sup> Only one of these bits can be set in any write operation, because they all determine the contents of the next operation.

### CONTROL REGISTER 2—ADDRESS 0X002

**Default Value 0x009B**

MSB

LSB

|   |   |   |   |   |   |   |   |   |   |   |   |   |    |      |   |      |
|---|---|---|---|---|---|---|---|---|---|---|---|---|----|------|---|------|
| 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | PD | LPWR | 1 | D1PD |
|---|---|---|---|---|---|---|---|---|---|---|---|---|----|------|---|------|

Table 18.

| Bit | Mnemonic | Comment   |
|-----|----------|---|
| 3   | PD       | Power Down. Setting this bit powers down the AD7763, reducing the power consumption to 6.35 mW.   |
| 2   | LPWR     | Low Power. If this bit is set, the AD7763 operates in a low power mode. The power consumption is reduced for a 3 dB reduction in noise performance. |
| 1   | 1        | 1 must be written to this bit.  |
| 0   | D1PD     | Differential Amplifier Power Down. Setting this bit powers down the on-chip differential amplifier.   |

**STATUS REGISTER (READ ONLY)**

| MSB    |        |       |       |       |   |      |     |       |           |         |        | LSB |      |      |      |
|--------|--------|-------|-------|-------|---|------|-----|-------|-----------|---------|--------|-----|------|------|------|
| PART 1 | PART 0 | DIE 2 | DIE 1 | DIE 0 | 0 | LPWR | OVR | DL_OK | FILTER_OK | UFILTER | BYP F3 | 1   | DEC2 | DEC1 | DEC0 |

Table 19.

| Bit      | Mnemonic  | Comment  |
|----------|-----------|--|
| 15,14    | PART[1:0] | Part Number. These bits are constant for the <a href="#">AD7763</a> .  |
| 13 to 11 | DIE[2:0]  | Die Number. These bits reflect the current <a href="#">AD7763</a> die number for identification purposes within a system.  |
| 10       | 0         | 0 must be written to this bit.   |
| 9        | LPWR      | Low Power. If the <a href="#">AD7763</a> is operating in low power mode, this bit is set to 1.   |
| 8        | OVR       | If the current analog input exceeds the current overrange threshold, this bit is set.  |
| 7        | DL_OK     | When downloading a user filter to the <a href="#">AD7763</a> , a checksum is generated. This checksum is compared to the one downloaded following the coefficients. If these checksums agree, this bit is set. |
| 6        | FILTER_OK | When a user-defined filter is in use, a checksum is generated when the filter coefficients pass through the filter. This generated checksum is compared to the one downloaded. If they match, this bit is set. |
| 5        | UFILTER   | If a user-defined filter is in use, this bit is set.   |
| 4        | BYP F3    | Bypass Filter 3. If Filter 3 is bypassed by setting the relevant bit in Control Register 1, this bit is also set.  |
| 3        | 1         | 1 must be written to this bit.   |
| 2 to 0   | DEC[2:0]  | Decimation Rate. These bits correspond to the bits set in Control Register 1.  |

**OFFSET REGISTER—ADDRESS 0X003*****Non Bit-Mapped, Default Value 0x0000***

The offset register uses twos complement notation and is scaled so that 0x7FFF (maximum positive value) and 0x8000 (maximum negative value) correspond to an offset of +0.390625% and -0.390625%, respectively. Offset correction is applied after any gain correction. Using the default gain value of 1.25 and assuming a reference voltage of 4.096 V, the offset correction range is approximately  $\pm 25$  mV.

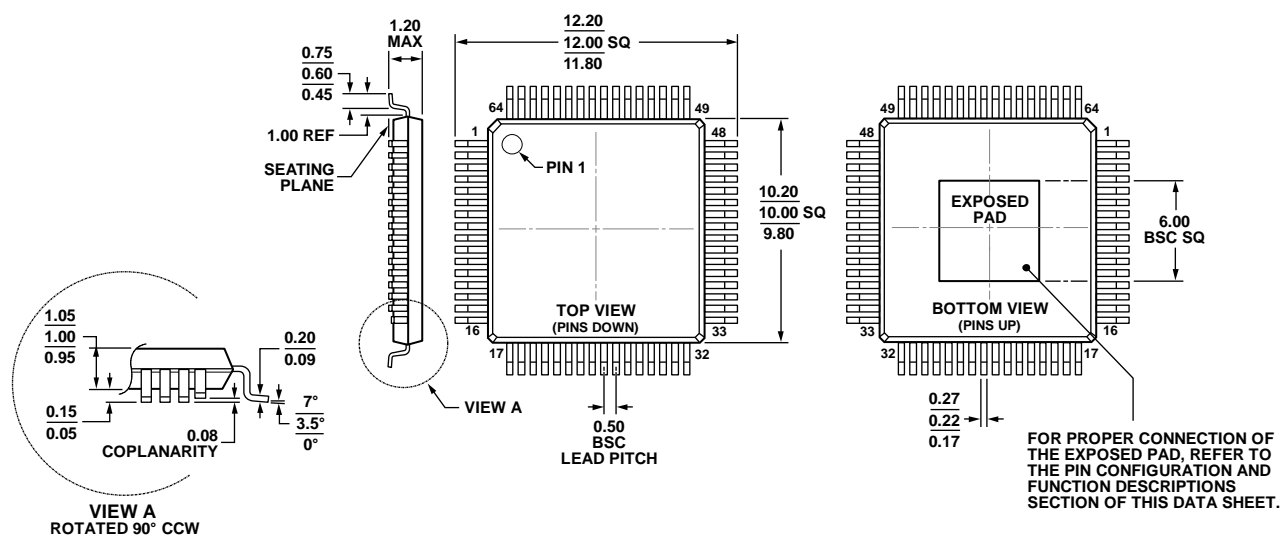
**GAIN REGISTER—ADDRESS 0X004*****Non Bit-Mapped, Default Value 0xA000***

The gain register is scaled so that 0x8000 corresponds to a gain of 1.0. The default value of this register is 1.25 (0xA000). This gives a full-scale digital output when the input is at 80% of  $V_{REF}$ . This ties in with the maximum analog input range of  $\pm 80\%$  of  $V_{REF}$  p-p.

**OVERRANGE REGISTER—ADDRESS 0X005*****Non Bit-Mapped, Default Value 0xCCCC***

The overrange register value is compared with the output of the first decimation filter to obtain an overload indication with minimum propagation delay. This is prior to any gain scaling or offset adjustment. The default value is 0xCCCC, which corresponds to 80% of  $V_{REF}$  (the maximum permitted analog input voltage). Assuming  $V_{REF} = 4.096$  V, the bit is then set when the input voltage exceeds approximately 6.55 V p-p differential. Note that the overrange bit is also set immediately if the analog input voltage exceeds 100% of  $V_{REF}$  for more than 4 consecutive samples at the modulator rate.

## OUTLINE DIMENSIONS



COMPLIANT TO JEDEC STANDARDS MS-026-ACD-HD

Figure 39. 64-Lead Thin Quad Flat Package, Exposed Pad [TQFP\_EP]  
(SV-64-2)

Dimensions shown in millimeters

## ORDERING GUIDE

| Model <sup>1</sup> | Temperature Range | Package Description                                   | Package Option |
|--------------------|-------------------|---|----------------|
| AD7763BSVZ         | −40°C to +85°C    | 64-Lead Thin Quad Flat Package, Exposed Pad (TQFP_EP) | SV-64-2        |
| AD7763BSVZ-REEL    | −40°C to +85°C    | 64-Lead Thin Quad Flat Package, Exposed Pad (TQFP_EP) | SV-64-2        |
| EVAL-AD7763EDZ     |                   | Evaluation Board                                      |                |

<sup>1</sup> Z = RoHS Compliant Part.

**NOTES**

## NOTES



**NOTES**